











SBAS650B - MAY 2014-REVISED JULY 2014

AFE4403

# AFE4403 Ultra-Small, Integrated Analog Front-End for Heart Rate Monitors and **Low-Cost Pulse Oximeters**

#### **Features**

- Fully-Integrated AFE for Pulse Oximeter and **Heart Rate Monitoring Applications:**
- Transmit:
  - Integrated Dual LED Driver (H-Bridge or Common Anode)
  - Option for a Third LED Support for Optimized SPO2, HRM, or Multi-Wavelength HRM
  - Up to 110-dB Dynamic Range
  - LED Current:
    - Programmable to 100 mA with 8-Bit **Current Resolution**
  - 30 μA + Average LED Current
  - Programmable LED On-Time
  - Independent LED2 and LED1 Current Reference
- Receive Channel with High Dynamic Range:
  - 22-Bit Output in Twos Complement Format
  - Up to 105-dB Dynamic Range
  - Low Power: < 650 μA</li>
  - Dynamic Power-Down Mode to Reduce Current to 300 µA
  - Adaptable to a Very Wide Range of Signal Amplitudes:
    - Total Programmable Gain: 10 k $\Omega$  to 4 M $\Omega$
  - Integrated Digital Ambient Estimation and Subtraction
- Flexible Clocking by External Clock or Crystal:
  - Pulse Frequency: 62.5 SPS to 2000 SPS
  - Flexible Pulse sequencing and Timing Control
  - Input Clock Range: 4 MHz (Min) to 60 MHz (Max)
- Integrated Fault Diagnostics:
  - Photodiode and LED Open and **Short Detection**
- Supplies:
  - Rx = 2.0 V to 3.6 V
  - Tx = 3.0 V to 5.25 V
- Package: Compact DSBGA-36  $(3.07 \text{ mm} \times 3.07 \text{ mm} \times 0.5 \text{ mm})$
- Specified Temperature Range: -20°C to 70°C

## 2 Applications

- Medical Pulse Oximeter Applications
- Optical HRM
- **Industrial Photometry Applications**

## 3 Description

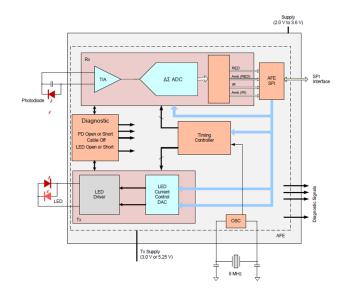
The AFE4403 is a fully-integrated analog front-end (AFE) ideally suited for pulse oximeter applications. The device consists of a low-noise receiver channel with an integrated analog-to-digital converter (ADC), an LED transmit section, and diagnostics for sensor and LED fault detection. The device is a very configurable timing controller. This flexibility enables the user to have complete control of the device timing characteristics. To ease clocking requirements and provide a low-jitter clock to the AFE4403, an oscillator is also integrated that functions from an external crystal. The device communicates to an external microcontroller or host processor using an SPI™ interface.

The device is a complete AFE solution packaged in a single, compact DSBGA-36 (3.07 mm x 3.07 mm x 0.5 mm) and is specified over the operating temperature range of -20°C to 70°C.

# Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)
AFF4403	DSBGA (36)	3.07 mm × 3.07 mm

(1) For all available packages, see the orderable addendum at the end of the datasheet.





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1	Features 1		8.2 Functional Block Diagram	20
2	Applications 1		8.3 Feature Description	21
3	Description 1		8.4 Device Functional Modes	45
4	Revision History2		8.5 Programming	53
5	Device Family Options		8.6 Register Maps	58
6	Pin Configuration and Functions	9	Application and Implementation	83
7	Specifications5		9.1 Application Information	83
•			9.2 Typical Application	83
	7.1 Absolute Maximum Ratings 5	10	Power Supply Recommendations	87
	7.2 Handling Ratings		10.1 Power Consumption Considerations	
	7.3 Recommended Operating Conditions 6	11	Layout	
	7.4 Thermal Information	• • •	=	
	7.5 Electrical Characteristics		.,	
	7.6 Timing Requirements		11.2 Layout Example	
	7.7 Timing Requirements: Supply Ramp and Power-	12	Device and Documentation Support	91
	Down12		12.1 Trademarks	91
	7.8 Typical Characteristics		12.2 Electrostatic Discharge Caution	91
8	Detailed Description 20		12.3 Glossary	91
	8.1 Overview	13	Mechanical, Packaging, and Orderable Information	91

# 4 Revision History

Changes from Revision A (June 2014) to Revision B		Page
<ul> <li>Changed Pin Configuration diagram: changed <i>Top View</i></li> <li>Added footnote to Figure 41</li> </ul>		
Added footnote to Figure 41		
Changes from Original (May 2014) to Revision A		Page
Changed document status to Production Data		
• Changed first and third sub-bullets of Flexible Clocking	Features bullet	
Changed MIN to NOM in Body Size column of Device I	nformation table	
Added Device Family Options table and Pin Configurati	on and Functions section	
Added Specifications section		
Added Detailed Description section		20
Added Application and Implementation section		83
Added Power Supply Recommendations section		
Added Layout section		90



# 5 Device Family Options

PRODUCT	PACKAGE-LEAD	LED DRIVE CONFIGURATION	LED DRIVE CURRENT (mA, max)	Tx POWER SUPPLY (V)	OPERATING TEMPERATURE RANGE
AFE4400	VQFN-40	Bridge, push-pull	50	3 to 5.25	0°C to 70°C
AFE4490	VQFN-40	Bridge, push-pull	50, 75, 100, 150, and 200	3 to 5.25	-40°C to 85°C
AFE4403	DSBGA-36	Bridge, push-pull	25, 50, 75, and 100	3 to 5.25	–20°C to 70°C

# 6 Pin Configuration and Functions

YZP Package DSBGA-36 (Bottom View)

	INN	RX_ANA_SUP	XIN	XOUT	DNC	RX_DIG_GND
F	0	0	0	0	0	0
E	INP	RX_ANA_GND	DNC	RX_ANA_SUP	RX_DIG_SUP	CLKOUT
Е	VCM	VSS	DNC	 RESET		SPISTE
D	0	0	0	O	ADC_RDY	0
	DNC	BG	AFE_PDN	SPISIMO	SPISOMI	SCLK
С	0	0	0	0	0	•
Б	TX_REF	RX_DIG_GND	TX3	DIAG_END	DNC	DNC
В	•	0	0	0	0	•
Α	DNC	TX_CTRL_SUP	LED_DRV_GND	TXN	TXP	LED_DRV_SUP
		_	_	_		_
	1	2	3	4	5	6



#### Pin Functions

			Pin Functions
PIN			
NAME	NO.	FUNCTION	DESCRIPTION
ADC_RDY	D5	Digital	Output signal that indicates ADC conversion completion. Can be connected to the interrupt input pin of an external microcontroller.
AFE_PDN	С3	Digital	AFE-only power-down input; active low. Can be connected to the port pin of an external microcontroller.
BG	C2	Reference	Decoupling capacitor for internal band-gap voltage to ground. Connect a decoupling capacitor to ground. To achieve the lowest transmitter noise, use a capacitor value of 2.2 µF. To reduce the recovery time from power-down (from 1 s to 0.1 s), use a capacitor value of 0.1 µF instead—but with slightly degraded transmitter noise.
CLKOUT	E6	Digital	Buffered 4-MHz output clock output. Can be connected to the clock input pin of an external microcontroller.
DIAG_END	B4	Digital	Output signal that indicates completion of diagnostics. Can be connected to the port pin of an external microcontroller.
DNC <sup>(1)</sup>	C1, A1, E3, D3, F5, B5, B6	_	Do not connect these pins. Leave as open circuit.
INN	F1	Analog	Receiver input pin. Connect to photodiode anode.
INP	E1	Analog	Receiver input pin. Connect to photodiode cathode.
LED_DRV_GND	A3	Supply	LED driver ground pin, H-bridge. Connect to common board ground.
LED_DRV_SUP	A6	Supply	LED driver supply pin, H-bridge. Connect to an external power supply capable of supplying t large LED current, which is drawn by this supply pin.
RESET	D4	Digital	AFE-only reset input, active low. Can be connected to the port pin of an external microcontroller
RX_ANA_GND	E2	Supply	Rx analog ground pin. Connect to common board ground.
RX_ANA_SUP	F2, E4	Supply	Rx analog supply pin; 0.1-µF decoupling capacitor to ground
RX_DIG_GND	B2, F6	Supply	Rx digital ground pin. Connect to common board ground.
RX_DIG_SUP	E5	Supply	Rx digital supply pin; 0.1-µF decoupling capacitor to ground
SCLK	C6	SPI	SPI clock pin
SPISIMO	C4	SPI	SPI serial in master out
SPISOMI	C5	SPI	SPI serial out master in
SPISTE	D6	SPI	SPI serial interface enable
TX_CTRL_SUP	A2	Supply	Transmit control supply pin (0.1-µF decoupling capacitor to ground)
TX_REF	B1	Reference	Transmitter reference voltage, 0.25 V default after reset. Connect a decoupling capacitor to ground. To achieve the lowest transmitter noise, use a capacitor value of 2.2 μF. To reduce the recovery time from power-down (from 1 s to 0.1 s), use a capacitor value of 0.1 μF instead—but with slightly degraded transmitter noise.
TXN	A4	Analog	LED driver out. Connect to LED in common anode or H-bridge configuration.
TXP	A5	Analog	LED driver out. Connect to LED in common anode or H-bridge configuration.
TX3	В3	Analog	LED driver out for third LED. Connect to optional third LED supported in common anode configuration.
VCM	D1	Reference	Input common-mode voltage output. This signal can be used to shield (guard) the INP, INN traces. If used as a shield, then connect a series resistor (1 k $\Omega$ ) and a decoupling capacitor (10 nF) ground. If VCM is not used externally, then these external components are not required.
VSS	D2	Supply	Substrate ground. Connect to common board ground.
XOUT	F4	Digital	Crystal oscillator pins. Connect an external crystal between these pins with the correct load capacitor (as specified by vendor) to ground.
XIN	F3	Digital	Crystal oscillator pins. Connect an external crystal between these pins with the correct load capacitor (as specified by vendor) to ground.

<sup>(1)</sup> Leave pins as open circuit. Do not connect.



# 7 Specifications

#### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

		MIN	MAX	UNIT
RX_ANA_SUP, R	X_DIG_SUP to RX_ANA_GND, RX_DIG_GND	-0.3	4	V
TX_CTRL_SUP, L	ED_DRV_SUP to LED_DRV_GND	-0.3	6	V
RX_ANA_GND, R	X_DIG_GND to LED_DRV_GND	-0.3	0.3	V
Analog inputs		RX_ANA_GND - 0.3	RX_ANA_SUP + 0.3	V
Digital inputs		RX_DIG_GND - 0.3	RX_DIG_SUP + 0.3	V
Input current to an	ny pin except supply pins <sup>(2)</sup>		±7	mA
Innut ourrent	Momentary		±50	mA
Input current	Continuous		±7	mA
Operating tempera	ature range	0–20	70	°C
Maximum junction	temperature, T <sub>J</sub>		125	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

## 7.2 Handling Ratings

			MIN	MAX	UNIT
T <sub>stg</sub>	Storage temperature range		-60	150	°C
V	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	-1000	1000	V
V(ESD)	V <sub>(ESD)</sub> Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	-250	250	V

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

<sup>(2)</sup> Input terminals are diode-clamped to the power-supply rails. Input signals that can swing beyond the supply rails must be current-limited to 10 mA or less.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



# 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

	PARAMETER		MIN	MAX	UNIT
SUPPLIES					
RX_ANA_SUP	AFE analog supply		2.0	3.6	V
RX_DIG_SUP	AFE digital supply		2.0	3.6	V
TX_CTRL_SUP	Transmit controller supply		3.0	5.25	V
LED DRV SUP	Transmit LED driver supply	H-bridge	[3.0 or (0.75 + V <sub>LED</sub> + V <sub>CABLE</sub> ) <sup>(1)(2)</sup> , whichever is greater]	), r] 5.25	V
LED_DRV_SUP	, C	Common anode configuration	[3.0 or $(0.5 + V_{LED} + V_{CABLE})^{(1)(2)}$ , whichever is greater]	5.25	V
	Difference between LED_DRV_SUP and TX_CTRL_SUP		-0.3	0.3	V
TEMPERATURE					
	Specified temperature range		-20	70	°C
	Storage temperature range		-60	150	°C

<sup>(1)</sup> V<sub>LED</sub> refers to the maximum voltage drop across the external LED (at maximum LED current) connected between the TXP and TXN pins (in H-bridge mode) and from the TXP and TXN pins to LED\_DRV\_SUP (in the common anode configuration).

#### 7.4 Thermal Information

		AFE4403	
	THERMAL METRIC <sup>(1)</sup>	YZP (WCSP)	UNIT
		36 BALLS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	49.8	
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	0.2	
$R_{\theta JB}$	Junction-to-board thermal resistance	8.5	°C/W
ΨЈТ	Junction-to-top characterization parameter	0.8	°C/VV
ΨЈВ	Junction-to-board characterization parameter	8.5	
R <sub>0JC(bot)</sub>	Junction-to-case (bottom) thermal resistance	n/a	

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

<sup>(2)</sup> V<sub>CABLE</sub> refers to voltage drop across any cable, connector, or any other component in series with the LED.



#### 7.5 Electrical Characteristics

Minimum and maximum specifications are at  $T_A = -20^{\circ}\text{C}$  to  $70^{\circ}\text{C}$ , typical specifications are at  $25^{\circ}\text{C}$ . Crystal mode enabled, detector capacitor = 50 pF differential, ADC averaging set to maximum allowed for each PRF, TX\_REF voltage set to 0.5 V, and CLKOUT tri-stated, at RX\_ANA\_SUP = RX\_DIG\_SUP = 3 V, TX\_CTRL\_SUP = LED\_DRV\_SUP = 3.3 V, stage 2 amplifier disabled, and  $f_{\text{CLK}} = 8 \text{ MHz}$ , unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN TYP MAX	UNIT
PERFORI	MANCE (Full-Signal Chain)			
		$R_F = 10 \text{ k}\Omega$	50	μΑ
		$R_F = 25 \text{ k}\Omega$	20	μA
		$R_F = 50 \text{ k}\Omega$	10	μΑ
I <sub>IN_FS</sub>	Full-scale input current	$R_F = 100 \text{ k}\Omega$	5	μΑ
		$R_F = 250 \text{ k}\Omega$	2	μΑ
		$R_F = 500 \text{ k}\Omega$	1	μΑ
		$R_F = 1 \text{ M}\Omega$	0.5	μΑ
PRF	Pulse repetition frequency		62.5 2000	SPS
$DC_{PRF}$	PRF duty cycle		25%	
CMRR	Common-mode rejection ratio	$f_{CM}$ = 50 Hz and 60 Hz, LED1 and LED2 with $R_{SERIES}$ = 500 $k\Omega,~R_F$ = 500 $k\Omega$	75	dB
CIVIKK	Common-mode rejection ratio	$f_{CM}$ = 50 Hz and 60 Hz, LED1-AMB and LED2-AMB with $R_{SERIES}$ = 500 k $\Omega,~R_F$ = 500 k $\Omega$	95	dB
PSRR <sub>LED</sub>	PSRR, transmit LED driver	With respect to ripple on LED_DRV_SUP	75	dB
$PSRR_{Tx}$	PSRR, transmit control	With respect to ripple on TX_CTRL_SUP	60	dB
PSRR <sub>Rx</sub>	PSRR, receiver	With respect to ripple on RX_ANA_SUP and RX_DIG_SUP	60	dB
re	Total integrated noise current, input-	$R_F = 100 \text{ k}\Omega$ , PRF = 600 Hz, duty cycle = 5%	25	$pA_{RMS}$
	referred (receiver with transmitter loop back, 0.1-Hz to 20-Hz bandwidth)	$R_F = 500 \text{ k}\Omega$ , PRF = 600 Hz, duty cycle = 5%	6	pA <sub>RMS</sub>
RECEIVE	R FUNCTIONAL BLOCK LEVEL SPECIF	ICATION		
	Total integrated noise current, input	$R_F$ = 500 kΩ, ambient cancellation enabled, stage 2 gain = 4, PRF = 1200 Hz, LED duty cycle = 25%	3.2	pA <sub>RMS</sub>
	referred (receiver alone) over 0.1-Hz to 20-Hz bandwidth	$R_F$ = 500 k $\Omega$ , ambient cancellation enabled, stage 2 gain = 4, PRF = 1200 Hz, LED duty cycle = 5%	5.3	pA <sub>RMS</sub>
I-V TRAN	SIMPEDANCE AMPLIFIER			
G	Gain	$R_F$ = 10 $k\Omega$ to 1 $M\Omega$	See the <i>Receiver Channel</i> section for details	V/µA
	Gain accuracy		±7%	
	Feedback resistance	R <sub>F</sub>	10k, 25k, 50k, 100k, 250k, 500k, and 1M	Ω
	Feedback resistor tolerance	R <sub>F</sub>	±20%	
	Feedback capacitance	$C_{F}$	5, 10, 25, 50, 100, and 250	pF
	Feedback capacitor tolerance	C <sub>F</sub>	±20%	
	Full-scale differential output voltage		1	V
	Common-mode voltage on input pins	Set internally	0.9	V
	External differential input capacitance	Includes equivalent capacitance of photodiode, cables, EMI filter, and so forth	10 1000	pF
	Shield output voltage, $V_{\text{CM}}$	With a 1-kΩ series resistor and a 10-nF decoupling capacitor to ground	0.8 0.9 1	V



## **Electrical Characteristics (continued)**

Minimum and maximum specifications are at  $T_A = -20$ °C to 70°C, typical specifications are at 25°C. Crystal mode enabled, detector capacitor = 50 pF differential, ADC averaging set to maximum allowed for each PRF, TX\_REF voltage set to 0.5 V, and CLKOUT tri-stated, at RX\_ANA\_SUP = RX\_DIG\_SUP = 3 V, TX\_CTRL\_SUP = LED\_DRV\_SUP = 3.3 V, stage 2 amplifier disabled, and  $f_{CLK} = 8$  MHz, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN T	YP MAX	UNIT
AMBIEN	T CANCELLATION STAGE		•		
	Gain		0, 3.5, 6, 9.5	5, and 12	dB
	Current DAC range		0	10	μA
	Current DAC step size			1	μA
LOW-PA	ASS FILTER		1		•
	Low-pass corner frequency	3-dB attenuation		500	Hz
		Duty cycle = 25%	0.0	004	dB
	Pass-band attenuation, 2 Hz to 10 Hz	Duty cycle = 10%	0.0	041	dB
	Filter settling time	After diagnostics mode		28	ms
ANALO	G-TO-DIGITAL CONVERTER	-			
	Resolution			22	Bits
	Sample rate	See the ADC Operation and Averaging Module section	4 × F	PRF	SPS
	ADC full-scale voltage		±	:1.2	V
	ADC conversion time	See the ADC Operation and Averaging Module section		PRF / 4	μs
	ADC reset time <sup>(1)</sup>		2		t <sub>CLK</sub>
TRANSI	MITTER	L			OL.
	Output current range		Selectable, (see the LEDC Control Registe	NTRL: LED	mA
	LED current DAC error		±1	0%	
	Output current resolution			8	Bits
	Transmitter noise dynamic range,	At 25-mA output current		110	dB
	over 0.1-Hz to 20-Hz bandwidth, TX_REF set to 0.5 V	At 50-mA output current	,	110	dB
	Minimum sample time of LED1 and LED2 pulses			50	μs
	LED augreent DAC lookens augreent	LED_ON = 0		1	μΑ
	LED current DAC leakage current	LED_ON = 1		50	μΑ
	LED current DAC linearity	Percent of full-scale current	C	.50	%
	Output current settling time	From zero current to 50 mA		7	μs
	(with resistive load)	From 50 mA to zero current		7	μs
DIAGNO	STICS				
	Duration of diagnostics state machine	Start of diagnostics after the DIAG_EN register bit is set. End of diagnostic is indicated by DIAG_END going high.		16	ms
	Open fault resistance		> '	100	kΩ
	Short fault resistance		<	: 10	kΩ
INTERN	AL OSCILLATOR				
f <sub>CLKOUT</sub>	CLKOUT frequency	With an 8-MHz crystal connected to the XIN, XOUT pins		4	MHz
	CLKOUT duty cycle		5	0%	
	Crystal oscillator start-up time	With an 8-MHz crystal connected to the XIN, XOUT pins		200	μs

<sup>(1)</sup> A low ADC reset time can result in a small component of the LED signal leaking into the ambient phase. With an ADC reset of two clock cycles, a –60-dB leakage is expected. In many cases, this leakage does not affect system performance. However, if this crosstalk must be completely eliminated, a longer ADC reset time of approximately six clock cycles is recommended for t<sub>22</sub>, t<sub>24</sub>, t<sub>26</sub>, and t<sub>28</sub> in Figure 48.



## **Electrical Characteristics (continued)**

Minimum and maximum specifications are at  $T_A = -20$ °C to 70°C, typical specifications are at 25°C. Crystal mode enabled, detector capacitor = 50 pF differential, ADC averaging set to maximum allowed for each PRF, TX\_REF voltage set to 0.5 V, and CLKOUT tri-stated, at RX\_ANA\_SUP = RX\_DIG\_SUP = 3 V, TX\_CTRL\_SUP = LED\_DRV\_SUP = 3.3 V, stage 2 amplifier disabled, and  $f_{CLK} = 8$  MHz, unless otherwise noted.

	PARAMETER	TEST CONDITIONS	MIN	TYP	MAX	UNIT
EXTERN	AL CLOCK		-			
		For SPO2 applications		50		ps
	Maximum allowable external clock jitter	For optical heart rate only			1000	ps
	External clock input frequency (2)	±2%	4	8	60	MHz
	Faternal also de inscrite cale	Voltage input high (V <sub>IH</sub> )	RX_DIG	0.75 x G_SUP		V
	External clock input voltage	Voltage input low (V <sub>IL</sub> )	RX_DIG	0.25 x 6_SUP		V
TIMING						
	Wake-up time from complete power-down			1000		ms
	Wake-up time from Rx power-down			100		μs
	Wake-up time from Tx power-down			1000		ms
t <sub>RESET</sub>	Active low RESET pulse duration			1		ms
t <sub>DIAGEND</sub>	DIAG_END pulse duration at the completion of diagnostics			4		CLKOUT cycles
t <sub>ADCRDY</sub>	ADC_RDY pulse duration			1		CLKOUT cycle
DIGITAL	SIGNAL CHARACTERISTICS					
V <sub>IH</sub>	Logic high input voltage	AFE_PDN, SCLK, SPISIMO, SPISTE, RESET	0.8 DVDD	> 1.3	DVDD + 0.1	V
V <sub>IL</sub>	Logic low input voltage	AFE_PDN, SCLK, SPISIMO, SPISTE, RESET	-0.1	< 0.4	0.2 DVDD	V
I <sub>IN</sub>	Logic input current	0 V < V <sub>DigitalInput</sub> < DVDD	-10		10	μΑ
V <sub>OH</sub>	Logic high output voltage	DIAG_END, SPISOMI, ADC_RDY, CLKOUT	0.9 > DVDD	· (RX_DI	G_SUP - 0.2 V)	V
V <sub>OL</sub>	Logic low output voltage	DIAG_END, SPISOMI, ADC_RDY, CLKOUT		< 0.4	0.1 DVDD	V
SUPPLY	CURRENT					
		RX_ANA_SUP = 3.0 V, with 8-MHz clock running, Rx stage 2 disabled		0.6		mA
	Receiver analog supply current	RX_ANA_SUP = 3.0 V, with 8-MHz clock running, Rx stage 2 enabled		0.7		mA
		RX_ANA_SUP = 3.0 V, with 8-MHz clock running, Rx stage 2 disabled, external clock mode		0.49		mA
	Receiver digital supply current	RX_DIG_SUP = 3.0 V		0.15		mA
	LED driver supply current	With zero LED current setting		30		μΑ
	Transmitter control supply current			15		μΑ
		Receiver current only (RX_ANA_SUP)		3		μΑ
	Complete power-down	Receiver current only (RX_DIG_SUP)		3		μΑ
	(using the AFE_PDN pin)	Transmitter current only (LED_DRV_SUP)		1		μA
		Transmitter current only (TX_CTRL_SUP)		1		μA
	Power-down Rx alone	Receiver current only (RX_ANA_SUP)		200		μA
	i ower-down its alone	Receiver current only (RX_DIG_SUP)		150		μA
	Power-down Tx alone	Transmitter current only (LED_DRV_SUP)		2		μA
	I OWGI-GOWII IA GIOIIC	Transmitter current only (TX_CTRL_SUP)		2		μA

<sup>(2)</sup> Refer to the CLKDIV[2:0] register bits for a detailed list of input clock frequencies that are supported.



## **Electrical Characteristics (continued)**

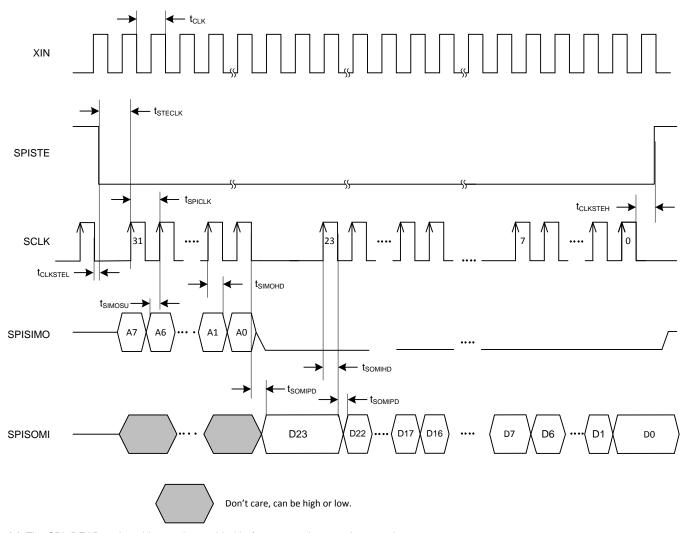
Minimum and maximum specifications are at  $T_A = -20$ °C to 70°C, typical specifications are at 25°C. Crystal mode enabled, detector capacitor = 50 pF differential, ADC averaging set to maximum allowed for each PRF, TX\_REF voltage set to 0.5 V, and CLKOUT tri-stated, at RX\_ANA\_SUP = RX\_DIG\_SUP = 3 V, TX\_CTRL\_SUP = LED\_DRV\_SUP = 3.3 V, stage 2 amplifier disabled, and  $f_{CLK} = 8$  MHz, unless otherwise noted.

PARAMETER		TEST (	CONDITIONS	MIN T	YP MAX	UNIT
POWER DISSIPATION		•	-			
	LED_DRV_SUP	Does not include LED current.			1	μA
Power-down with	TX_CTRL_SUP				1	μΑ
the AFE_PDN pin	RX_ANA_SUP				5	μΑ
	RX_DIG_SUP			(	0.1	μΑ
	LED_DRV_SUP	Does not include LED curre	ent.	1		μA
Power-down with the PDNAFE	TX_CTRL_SUP				1	μΑ
register bit	RX_ANA_SUP				15	μA
	RX_DIG_SUP				20	μA
	LED_DRV_SUP	Does not include LED curre	ent.		30	μA
Power-down Rx	TX_CTRL_SUP				15	μA
Fower-down KX	RX_ANA_SUP			2	200	μΑ
	RX_DIG_SUP			1	50	μΑ
	LED_DRV_SUP	Does not include LED curre	ent.		•	μΑ
Power-down Tx	TX_CTRL_SUP				2	μA
i owei-down ix	RX_ANA_SUP			6	600	μΑ
	RX_DIG_SUP			1	50	μΑ
	LED_DRV_SUP	Does not include LED curre	ent.		30	μΑ
After reset, with 8-	TX_CTRL_SUP				15	μΑ
MHz clock running	RX_ANA_SUP			6	600	μΑ
	RX_DIG_SUP			1	50	μΑ
	LED_DRV_SUP	Does not include LED curre	ent.		30	μΑ
With stage 2 mode enabled and 8-MHz	TX_CTRL_SUP				15	μΑ
clock running	RX_ANA_SUP				<b>'</b> 00	μΑ
	RX_DIG_SUP			1	50	μΑ
	LED_DRV_SUP	Does not include LED current.			7	μA
Dynamic power- down mode enabled	TX_CTRL_SUP		PRF = 100 Hz, PDN_CYCLE duration = 8 ms		5	μΑ
down mode enabled	RX_ANA_SUP		20	205	μA	
	RX_DIG_SUP			1	50	μA



## 7.6 Timing Requirements

	PARAMETER	MIN	TYP	MAX	UNIT
t <sub>CLK</sub>	Clock frequency on the XIN pin		8		MHz
t <sub>SCLK</sub>	Serial shift clock period	62.5			ns
t <sub>STECLK</sub>	STE low to SCLK rising edge, setup time	10			ns
t <sub>CLKSTEH,L</sub>	SCLK transition to SPI STE high or low	10			ns
t <sub>SIMOSU</sub>	SIMO data to SCLK rising edge, setup time	10			ns
t <sub>SIMOHD</sub>	Valid SIMO data after SCLK rising edge, hold time	10			ns
t <sub>SOMIPD</sub>	SCLK falling edge to valid SOMI, setup time	17			ns
t <sub>SOMIHD</sub>	SCLK rising edge to invalid data, hold time	0.5			t <sub>SCLK</sub>



- (1) The SPI\_READ register bit must be enabled before attempting a register read.
- (2) Specify the register address whose contents must be read back on A[7:0].
- (3) The AFE outputs the contents of the specified register on the SPISOMI pin.

Figure 1. Serial Interface Timing Diagram, Read Operation<sup>(1)(2)(3)</sup>



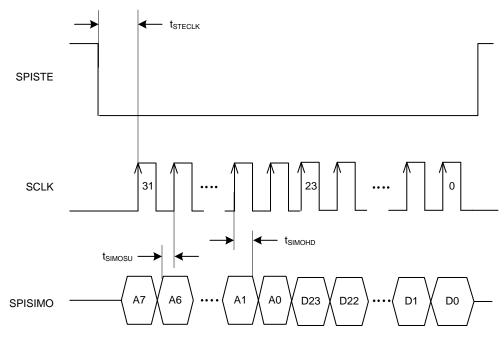


Figure 2. Serial Interface Timing Diagram, Write Operation

#### 7.7 Timing Requirements: Supply Ramp and Power-Down

	PARAMETER	VALUE
t <sub>1</sub>	Time between Rx and Tx supplies ramping up	Keep as small as possible (for example, ±10 ms)
t <sub>2</sub>	Time between both supplies stabilizing and high-going RESET edge	> 100 ms
t <sub>3</sub>	RESET pulse duration	> 0.5 ms
t <sub>4</sub>	Time between RESET and SPI commands	> 1 µs
t <sub>5</sub>	Time between SPI commands and the ADC_RESET which corresponds to valid data	> 3 ms of cumulative sampling time in each phase (1)(2)(3)
t <sub>6</sub>	Time between $\overline{\mbox{RESET}}$ pulse and high-accuracy data coming out of the signal chain	> 1 s <sup>(3)</sup>
t <sub>7</sub>	Time from AFE_PDN high-going edge and RESET pulse <sup>(4)</sup>	> 100 ms
t <sub>8</sub>	Time from AFE_PDN high-going edge (or PDN_AFE bit reset) to high-accuracy data coming out of the signal chain	> 1 s <sup>(3)</sup>

- (1) This time is required for each of the four switched RC filters to fully settle to the new settings. The same time is applicable whenever there is a change to any of the signal chain controls (for example, LED current setting, TIA gain, and so forth).
- (2) If the SPI commands involve a change in the TX\_REF value from its default, then there is additional wait time of approximately 1 s (for a 2.2-μF decoupling capacitor on the TX\_REF pin).
- (3) Dependent on the value of the capacitors on the BG and TX\_REF pins. The 1-s wait time is necessary when the capacitors are 2.2 μF and scale down proportionate to the capacitor value. A very low capacitor (for example, 0.1 μF) on these pins causes the transmitter dynamic range to reduce to approximately 100 dB.

(4) After an active power-down from AFE\_PDN, the device should be reset using a low-going RESET pulse.



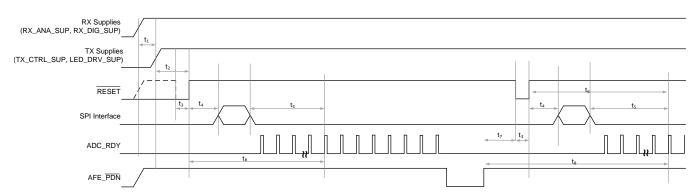


Figure 3. Supply Ramp and Hardware Power-Down Timing

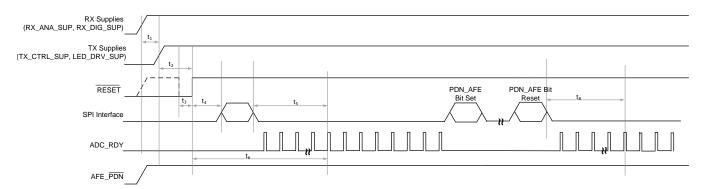
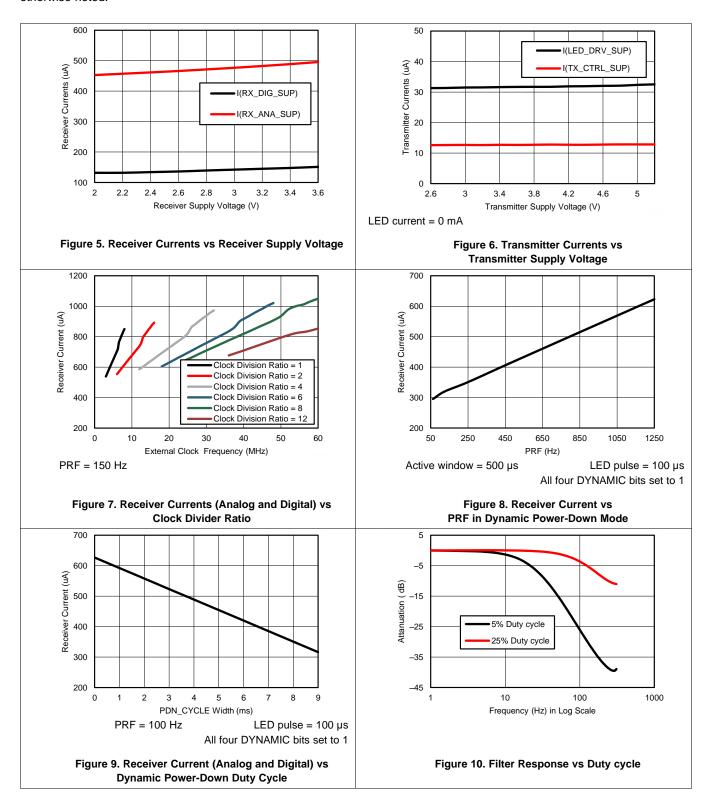


Figure 4. Supply Ramp and Software Power-Down Timing

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## 7.8 Typical Characteristics

At PRF = 100 Hz, 25% duty cycle,  $R_F$  = 500 k $\Omega$ ,  $C_F$  is adjusted to keep TIA time constant at 1/10th of sampling duration, All supplies at 3.3 V, 8-MHz external clock, CLKOUT tri-state, 1- $\mu$ F capacitor on TX\_REF and BG pins, detector  $C_{IN}$  = 50 pF, TX\_REF = 0.5 V, ADC averaging = max allowed, and SNR in dBFS is noise referred to full-scale range of 2 V, unless otherwise noted.

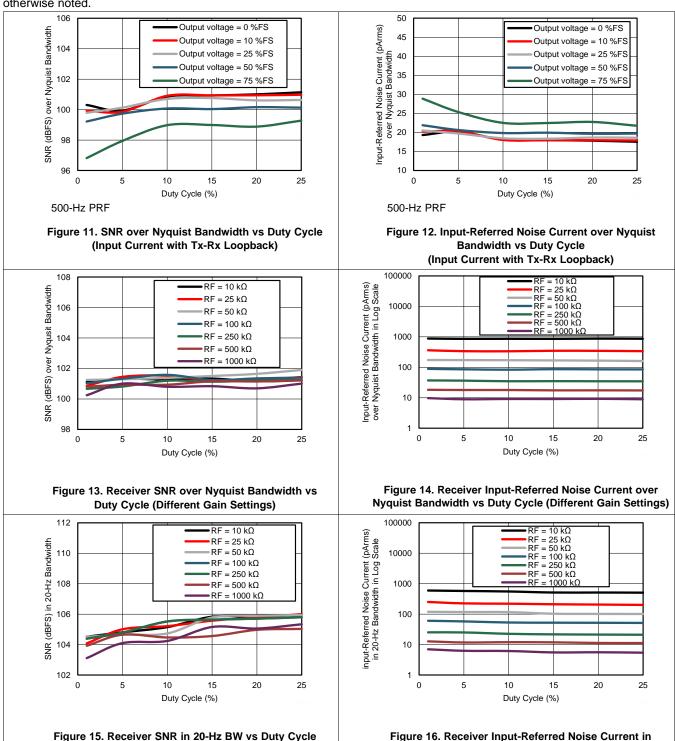


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At PRF = 100 Hz, 25% duty cycle,  $R_F$  = 500 k $\Omega$ ,  $C_F$  is adjusted to keep TIA time constant at 1/10th of sampling duration, All supplies at 3.3 V, 8-MHz external clock, CLKOUT tri-state, 1-µF capacitor on TX\_REF and BG pins, detector C<sub>IN</sub> = 50 pF, TX\_REF = 0.5 V, ADC averaging = max allowed, and SNR in dBFS is noise referred to full-scale range of 2 V, unless otherwise noted.



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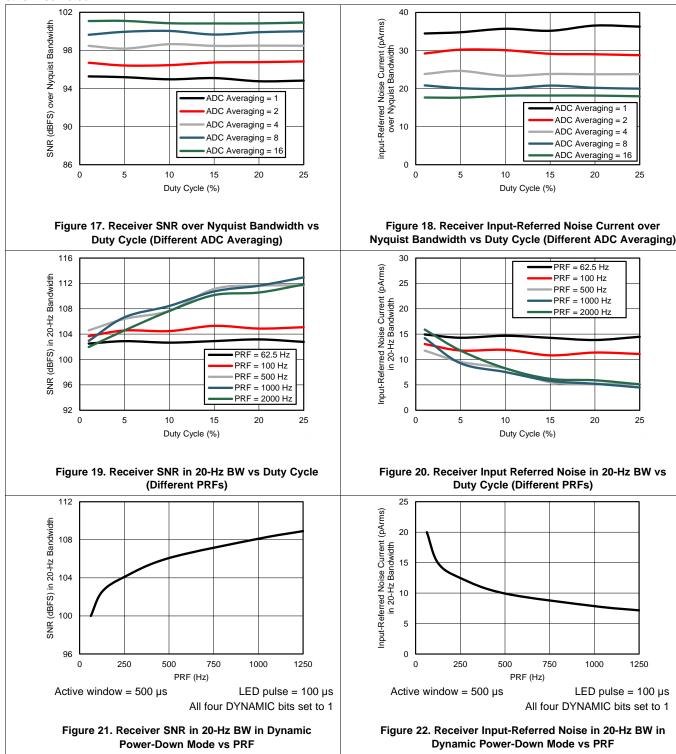
Product Folder Links: AFE4403

(Different Gain Settings)

20-Hz BW vs Duty Cycle (Different Gain Settings)



At PRF = 100 Hz, 25% duty cycle,  $R_F$  = 500 k $\Omega$ ,  $C_F$  is adjusted to keep TIA time constant at 1/10th of sampling duration, All supplies at 3.3 V, 8-MHz external clock, CLKOUT tri-state, 1- $\mu$ F capacitor on TX\_REF and BG pins, detector  $C_{IN}$  = 50 pF, TX\_REF = 0.5 V, ADC averaging = max allowed, and SNR in dBFS is noise referred to full-scale range of 2 V, unless otherwise noted.

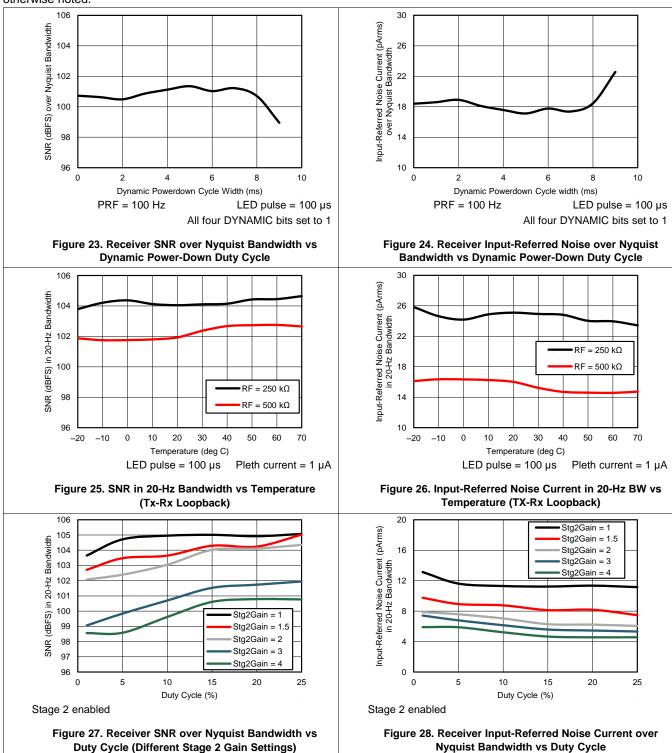


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At PRF = 100 Hz, 25% duty cycle,  $R_F$  = 500 k $\Omega$ ,  $C_F$  is adjusted to keep TIA time constant at 1/10th of sampling duration, All supplies at 3.3 V, 8-MHz external clock, CLKOUT tri-state, 1- $\mu$ F capacitor on TX\_REF and BG pins, detector  $C_{IN}$  = 50 pF, TX\_REF = 0.5 V, ADC averaging = max allowed, and SNR in dBFS is noise referred to full-scale range of 2 V, unless otherwise noted.



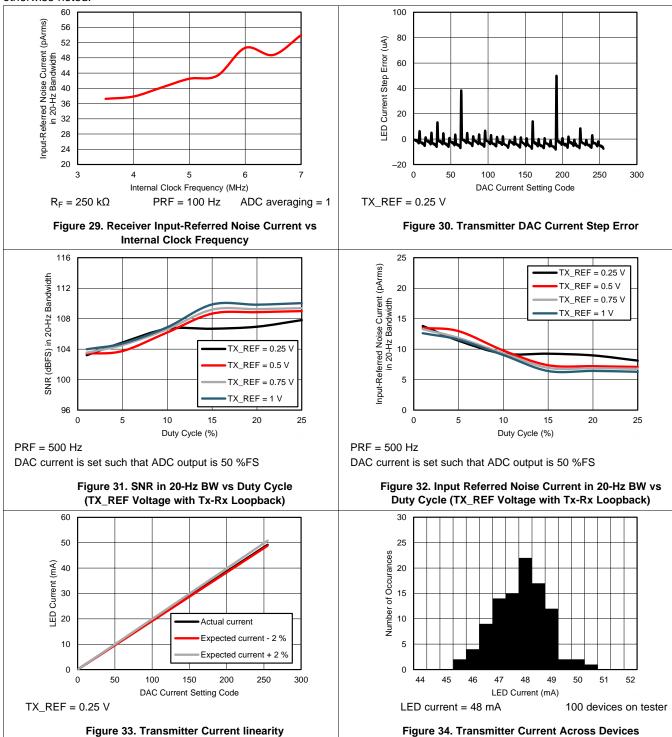
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(Different Stage 2 Gain Settings)

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# **Typical Characteristics (continued)**

At PRF = 100 Hz, 25% duty cycle,  $R_F$  = 500 k $\Omega$ ,  $C_F$  is adjusted to keep TIA time constant at 1/10th of sampling duration, All supplies at 3.3 V, 8-MHz external clock, CLKOUT tri-state, 1- $\mu$ F capacitor on TX\_REF and BG pins, detector  $C_{IN}$  = 50 pF, TX\_REF = 0.5 V, ADC averaging = max allowed, and SNR in dBFS is noise referred to full-scale range of 2 V, unless otherwise noted.

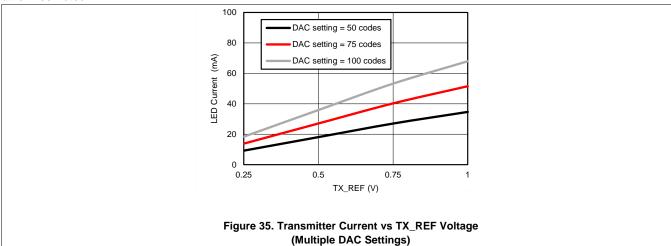


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At PRF = 100 Hz, 25% duty cycle,  $R_F$  = 500 k $\Omega$ ,  $C_F$  is adjusted to keep TIA time constant at 1/10th of sampling duration, All supplies at 3.3 V, 8-MHz external clock, CLKOUT tri-state, 1- $\mu$ F capacitor on TX\_REF and BG pins, detector  $C_{IN}$  = 50 pF, TX\_REF = 0.5 V, ADC averaging = max allowed, and SNR in dBFS is noise referred to full-scale range of 2 V, unless otherwise noted.



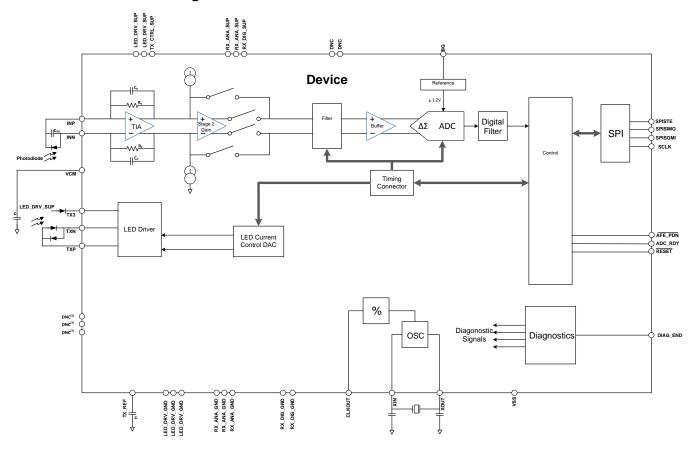


## 8 Detailed Description

#### 8.1 Overview

The AFE4403 is a complete analog front-end (AFE) solution targeted for pulse oximeter applications. The device consists of a low-noise receiver channel, an LED transmit section, and diagnostics for sensor and LED fault detection. To ease clocking requirements and provide the low-jitter clock to the AFE, an oscillator is also integrated that functions from an external crystal. The device communicates to an external microcontroller or host processor using an SPI interface. The *Functional Block Diagram* section provides a detailed block diagram for the AFE4403. The blocks are described in more detail in the following sections.

### 8.2 Functional Block Diagram



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#### 8.3 Feature Description

#### 8.3.1 Receiver Channel

This section describes the functionality of the receiver channel.

#### 8.3.1.1 Receiver Front-End

The receiver consists of a differential current-to-voltage (I-V) transimpedance amplifier (TIA) that converts the input photodiode current into an appropriate voltage, as shown in Figure 36. The feedback resistor of the amplifier ( $R_F$ ) is programmable to support a wide range of photodiode currents. Available  $R_F$  values include: 1 M $\Omega$ , 500 k $\Omega$ , 250 k $\Omega$ , 100 k $\Omega$ , 50 k $\Omega$ , 25 k $\Omega$ , and 10 k $\Omega$ .

The device is ideally suited as a front-end for a PPG (photoplethysmography) application. In such an application, the light from the LED is reflected (or transmitted) from (or through) the various components inside the body (such as blood, tissue, and so forth) and are received by the photodiode. The signal received by the photodiode has three distinct components:

- 1. A pulsatile or ac component that arises as a result of the changes in blood volume through the arteries.
- 2. A constant dc signal that is reflected or transmitted from the time invariant components in the path of light. This constant dc component is referred to as the pleth signal.
- 3. Ambient light entering the photodiode.

The ac component is usually a small fraction of the pleth component, with the ratio referred to as the perfusion index (PI). Thus, the allowed signal chain gain is usually determined by the amplitude of the dc component.

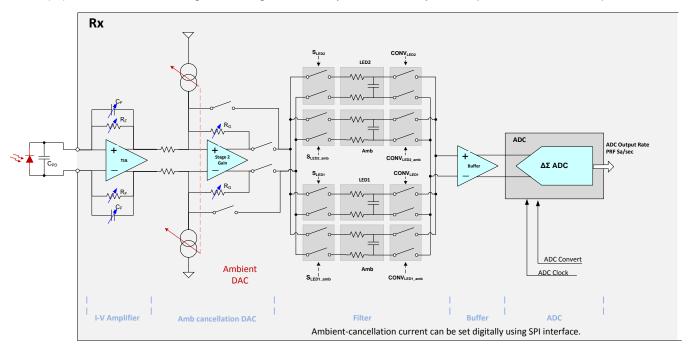


Figure 36. Receiver Front-End

The  $R_F$  amplifier and the feedback capacitor ( $C_F$ ) form a low-pass filter for the input signal current. Always ensure that the low-pass filter RC time constant has sufficiently high bandwidth (as shown by Equation 1) because the input current consists of pulses. For this reason, the feedback capacitor is also programmable. Available  $C_F$  values include: 5 pF, 10 pF, 25 pF, 50 pF, 100 pF, and 250 pF. Any combination of these capacitors can also be used.

$$R_{\rm F} \times C_{\rm F} \leq \frac{{\rm Rx~Sample~Time}}{10} \tag{1}$$



The output voltage of the I-V amplifier includes the pleth component (the desired signal) and a component resulting from the ambient light leakage. The I-V amplifier is followed by the second stage, which consists of a current digital-to-analog converter (DAC) that sources the cancellation current and an amplifier that gains up the pleth component alone. The amplifier has five programmable gain settings: 0 dB, 3.5 dB, 6 dB, 9.5 dB, and 12 dB. The gained-up pleth signal is then low-pass filtered (500-Hz bandwidth) and buffered before driving a 22-bit ADC. The current DAC has a cancellation current range of 10  $\mu$ A with 10 steps (1  $\mu$ A each). The DAC value can be digitally specified with the SPI interface. Using ambient compensation with the ambient DAC allows the dc-biased signal to be centered to near mid-point of the amplifier (±0.9 V). Using the gain of the second stage allows for more of the available ADC dynamic range to be used.

The output of the ambient cancellation amplifier is separated into LED2 and LED1 channels. When LED2 is on, the amplifier output is filtered and sampled on capacitor  $C_{\text{LED2}}$ . Similarly, the LED1 signal is sampled on the  $C_{\text{LED1}}$  capacitor when LED1 is on. In between the LED2 and LED1 pulses, the idle amplifier output is sampled to estimate the ambient signal on capacitors  $C_{\text{LED2}}$  amb and  $C_{\text{LED1}}$  amb.

The sampling duration is termed the *Rx sample time* and is programmable for each signal, independently. The sampling can start after the I-V amplifier output is stable (to account for LED and cable settling times). The Rx sample time is used for all dynamic range calculations; the minimum time recommended is 50 µs. While the AFE4403 can support pulse widths lower than 50 us, having too low a pulse width could result in a degraded signal and noise from the photodiode.

A single, 22-bit ADC converts the sampled LED2, LED1, and ambient signals sequentially. Each conversion provides a single digital code at the ADC output. As discussed in the *Receiver Timing* section, the conversions are meant to be staggered so that the LED2 conversion starts after the end of the LED2 sample phase, and so on.

Note that four data streams are available at the ADC output (LED2, LED1, ambient LED2, and ambient LED1) at the same rate as the pulse repetition frequency. The ADC is followed by a digital ambient subtraction block that additionally outputs the (LED2 – ambient LED2) and (LED1 – ambient LED1) data values.

The model of the photodiode and the connection to the TIA is shown in Figure 37.

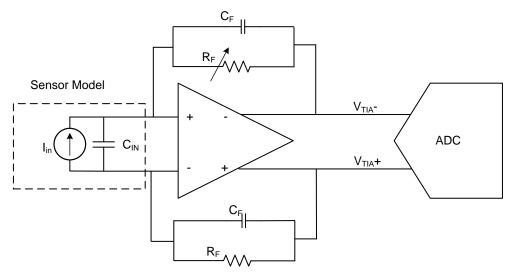


Figure 37. TIA Block Diagram

 $I_{in}$  is the signal current generated by the photodiode in response to the incident light.  $C_{in}$  is the zero-bias capacitance of the photodiode. The current-to-voltage gain in the TIA is given by Equation 2:

$$V_{TIA} (diff) = V_{TIA}^{+} - V_{TIA}^{-} = 2 \times I_{in} \times R_{F}$$
(2)



For example, for a photodiode current of  $I_{in}$  = 1  $\mu$ A and a TIA gain setting of  $R_F$  = 100  $k\Omega$ , the differential output of the TIA is equal to 200 mV. The TIA has an operating range of ±1 V, and the ADC has an input full-scale range of ±1.2 V (the extra margin is to prevent the ADC from saturating while operating the TIA at the fullest output range). Furthermore, because the PPG signal is one-sided, only one half of the full-scale is used. TI recommends operating the device at a dc level that is not more than 50% to 60% of the ADC full-scale. The margin allows for sudden changes in the signal level that might saturate the signal chain if operating too close to full-scale. Signal levels are shown in Figure 38:

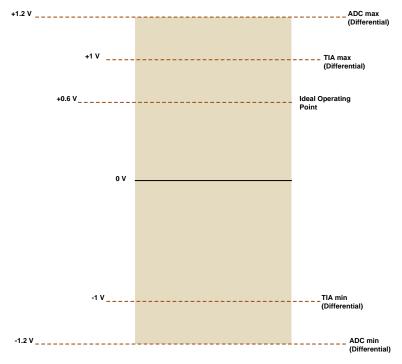


Figure 38. Signal Levels in TIA and ADC

On startup, a gain calibration algorithm running on the microcontroller unit (MCU) can be used to monitor the dc level and adjusts the LED current and TIA gain to get close to the target dc level. In addition to a target dc level, a high and low threshold (for example 80% and 20% of full-scale) can be determined that can cause the algorithm to switch to a different TIA gain or LED current setting when the signal amplitude changes beyond these thresholds.

In heart rate monitoring (HRM) applications demanding small-form factors, the sensor size can be so small (and the signal currents so low) that they do not occupy even 50% of full-scale even with the highest TIA gain setting of 1 M $\Omega$ , which is the case for signal currents that are less than 300 nA. As such, experimentation with various use cases is essential in order to determine the optimal target value, as well as high and low thresholds. Also, by enabling the stage 2 and introducing additional gain (up to 12 dB), a few extra decibels of SNR can be achieved.



#### 8.3.1.2 Ambient Cancellation Scheme and Second Stage Gain Block

The receiver provides digital samples corresponding to ambient duration. The host processor (external to the AFE) can use these ambient values to estimate the amount of ambient light leakage. The processor must then set the value of the ambient cancellation DAC using the SPI, as shown in Figure 39.

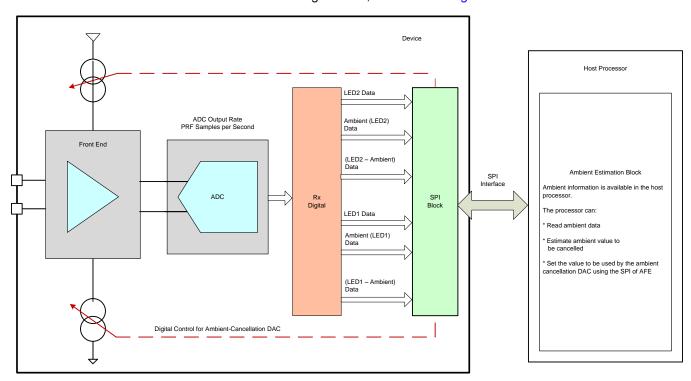


Figure 39. Ambient Cancellation Loop (Closed by the Host Processor)



Using the set value, the ambient cancellation stage subtracts the ambient component and gains up only the pleth component of the received signal; see Figure 40. The amplifier gain is programmable to 0 dB, 3.5 dB, 6 dB, 9.5 dB, and 12 dB.

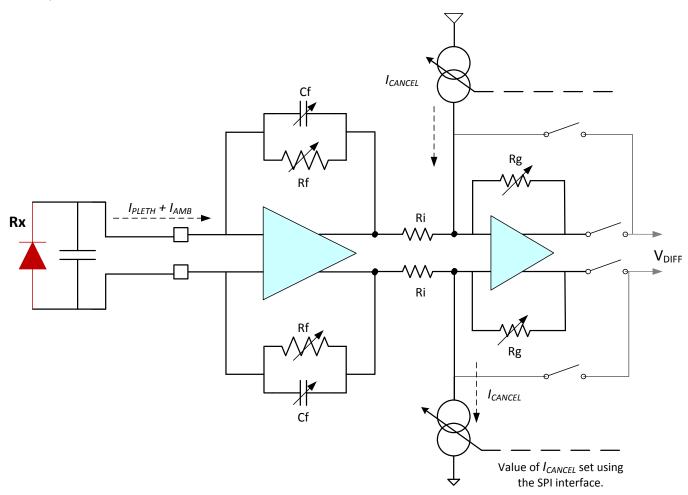


Figure 40. Front-End (I-V Amplifier and Cancellation Stage)

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(3)



#### **Feature Description (continued)**

The differential output of the second stage is V<sub>DIFF</sub>, as given by Equation 3:

$$V_{\text{DIFF}} = 2 \times \left[ I_{\text{PLETH}} \times \frac{R_{\text{F}}}{R_{\text{I}}} + I_{\text{AMB}} \times \frac{R_{\text{F}}}{R_{\text{I}}} - I_{\text{CANCEL}} \right] \times R_{\text{G}}$$

#### where:

- R<sub>i</sub> = 100 kΩ,
- I<sub>PLETH</sub> = photodiode current pleth component,
- I<sub>AMB</sub> = photodiode current ambient component, and
- I<sub>CANCEL</sub> = the cancellation current DAC value (as estimated by the host processor).

R<sub>G</sub> values with various gain settings are listed in Table 1.

Table 1. R<sub>G</sub> Values

GAIN	R <sub>G</sub> (kΩ)
0 (x1)	100
3.5 (x1.5)	150
6 (x2)	200
9.5 (x3)	300
12 (x4)	400

#### 8.3.1.3 Receiver Control Signals

**LED2 sample phase (S<sub>LED2</sub> or S<sub>R</sub>):** When this signal is high, the amplifier output corresponds to the LED2 ontime. The amplifier output is filtered and sampled into capacitor  $C_{LED2}$ . To avoid settling effects resulting from the LED or cable, program  $S_{LED2}$  to start after the LED turns on. This settling delay is programmable.

Ambient sample phase ( $S_{LED2\_amb}$  or  $S_{R\_amb}$ ): When this signal is high, the amplifier output corresponds to the LED2 off-time and can be used to estimate the ambient signal (for the LED2 phase). The amplifier output is filtered and sampled into capacitor  $C_{LED2\_amb}$ .

**LED1 sample phase (S<sub>LED1</sub> or S<sub>IR</sub>):** When this signal is high, the amplifier output corresponds to the LED1 ontime. The amplifier output is filtered and sampled into capacitor  $C_{LED1}$ . To avoid settling effects resulting from the LED or cable, program  $S_{LED1}$  to start after the LED turns on. This settling delay is programmable.

Ambient sample phase ( $S_{LED1\_amb}$  or  $S_{IR\_amb}$ ): When this signal is high, the amplifier output corresponds to the LED1 off-time and can be used to estimate the ambient signal (for the LED1 phase). The amplifier output is filtered and sampled into capacitor  $C_{LED1\_amb}$ .

**LED2 convert phase (CONV<sub>LED2</sub> or CONV<sub>R</sub>):** When this signal is high, the voltage sampled on C<sub>LED2</sub> is buffered and applied to the ADC for conversion. At the end of the conversion, the ADC provides a single digital code corresponding to the LED2 sample.

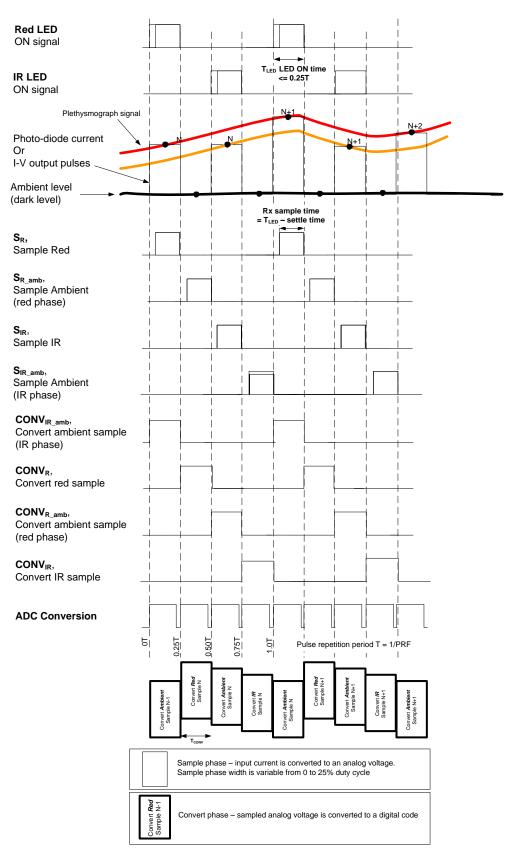
Ambient convert phases (CONV<sub>LED2\_amb</sub> or CONV<sub>R\_amb</sub>, CONV<sub>LED1\_amb</sub> or CONV<sub>IR\_amb</sub>): When this signal is high, the voltage sampled on  $C_{LED2_amb}$  (or  $C_{LED1_amb}$ ) is buffered and applied to the ADC for conversion. At the end of the conversion, the ADC provides a single digital code corresponding to the ambient sample.

**LED1 convert phase (CONV**<sub>LED1</sub> or **CONV**<sub>IR</sub>): When this signal is high, the voltage sampled on  $C_{LED1}$  is buffered and applied to the ADC for conversion. At the end of the conversion, the ADC provides a single digital code corresponding to the LED1 sample.

#### 8.3.1.4 Receiver Timing

See Figure 41 for a timing diagram detailing the control signals related to the LED on-time, Rx sample time, and the ADC conversion times for each channel. Figure 41 shows the timing for a case where each phase occupies 25% of the pulse repetition period. However, this percentage is not a requirement. In cases where the device is operated with low pulse repetition frequency (PRF) or low LED pulse durations, the active portion of the pulse repetition period can be reduced. Using the dynamic power-down feature, the overall power consumption can be significantly reduced.





NOTE: Relationship to the AFE4403 EVM is: LED1 = IR and LED2 = RED.

Figure 41. Rx Timing Diagram



#### 8.3.2 Clocking and Timing Signal Generation

The crystal oscillator generates a master clock signal using an external crystal. In the default mode, a divide-by-2 block converts the 8-MHz clock to 4 MHz, which is used by the AFE to operate the timer modules, ADC, and diagnostics. The 4-MHz clock is buffered and output from the AFE in order to clock an external microcontroller. The clocking functionality is shown in Figure 42.

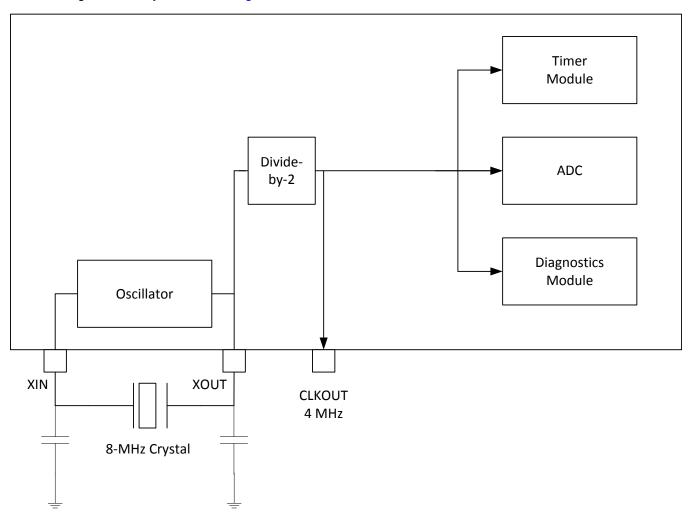


Figure 42. AFE Clocking

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To enable flexible clocking, the AFE4403 has a clock divider with programmable division ratios. While the default division ratio is divide-by-2, the clock divider can be programmed to select between ratios of 1, 2, 4, 6, 8, or 12. The division ratio should be selected based on the external clock input frequency such that the divided clock has a frequency close to 4 MHz. For this reason, CLKOUT is referred as <u>a 4-MHz</u> clock in this document. When operating with an external clock input, the divider is reset based on the RESET rising edge. Figure 43 shows the case where the divider ratio is set to divide-by-2.

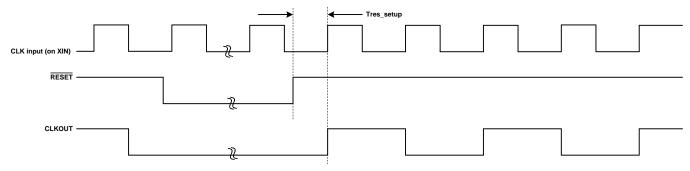


Figure 43. Clock Divider Reset

The device supports both external clock mode as well as an internal clock mode with external crystal.

In the external clock mode, an external clock is input on the XIN pin and the device internally generates the internal clock (used by the timing engine and the ADC) by a programmable division ratio. After division, the internal clock should be within a range of 4 MHz to 6 MHz. The exact frequency of this divided clock is one of the pieces of information required to establish the heart rate being measured from the pulse data.

In internal clock mode, an external crystal (connected between XIN and XOUT) is used to generate the clock. To generate sustained oscillations, the oscillator within the AFE provides negative resistance to cancel out the ESR of the crystal. A good rule of thumb is to limit the ESR of the crystal to less than a third of the negative resistance achievable by the oscillator. Figure 44 shows the connection of Crystal to AFE4403.

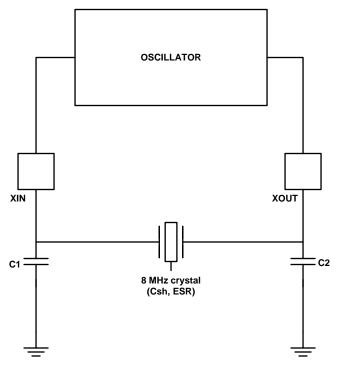


Figure 44. Connection of Crystal to AFE4403

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In Figure 44 the crystal is characterized by a capacitance,  $C_{sh}$  (shunt capacitance of the crystal) and an equivalent series resistance (ESR). C1 and C2 are external capacitors added at the XIN and XOUT pins.

The negative resistance achievable from the internal oscillator is given by Equation 4:

$$R = -1 / (2 \times \omega \times C_{sh} \times [1 + C_{sh} / C_L])$$

where

- $C_1 = (C1 \times C2) / (C1 + C2)$
- ω is the frequency of oscillation in rads,
- C<sub>sh</sub> is the shunt capacitor of the crystal, and
- C1, C2 are the capacitors to ground from the XIN, XOUT pins. A value of approximately 15 pF is recommended for C1, C2.

For example, with  $C_{sh} = 8$  pF, C1 = C2 = 15 pF, and a frequency of 8 MHz, the result is Equation 5:

$$R = -600 \Omega \tag{5}$$

Thus, the crystal ESR is limited to less than approximately 200  $\Omega$ .

TI highly recommends that a single clock source be used to generate the clock required by the AFE as well as the clock needed by the microcontroller (MCU). If an independent clock source is used by the MCU, then any energy coupling into the AFE supply or ground or input pins can cause aliased spurious tones close to the heart rate being measured. To enable operation with the single clock source between the AFE and the MCU, two options are possible:

- 1. **AFE clock as master:** The AFE uses a crystal to generate its clock. CLKOUT from the AFE is used as the input clock for the MCU.
- 2. MCU clock as master: The AFE operates with an external clock provided by the MCU.

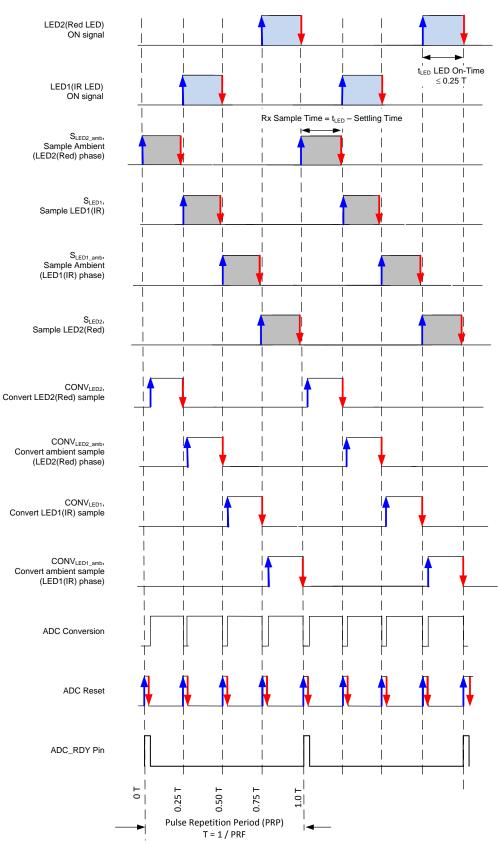
Note that the switching of CLKOUT consumes power. Thus, if CLKOUT is not used, it can be shut off using the CLKOUT\_TRI bit.

#### 8.3.3 Timer Module

See Figure 45 for a timing diagram detailing the various timing edges that are programmable using the timer module. The rising and falling edge positions of 11 signals can be controlled. The module uses a single 16-bit counter (running off of the 4-MHz clock) to set the time-base.

All timing signals are set with reference to the pulse repetition period (PRP). Therefore, a dedicated compare register compares the 16-bit counter value with the reference value specified in the PRF register. Every time that the 16-bit counter value is equal to the reference value in the PRF register, the counter is reset to 0.





NOTE: Programmable edges are shown in blue and red.

Figure 45. AFE Control Signals



For the timing signals in Figure 41, the start and stop edge positions are programmable with respect to the PRF period. Each signal uses a separate timer compare module that compares the counter value with preprogrammed reference values for the start and stop edges. All reference values can be set using the SPI interface.

After the counter value has exceeded the stop reference value, the output signal is set. When the counter value equals the stop reference value, the output signal is reset. Figure 46 shows a diagram of the timer compare register. With a 4-MHz clock, the edge placement resolution is 0.25 µs.

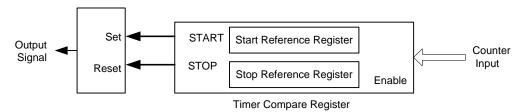


Figure 46. Compare Register

The ADC conversion signal requires four pulses in each PRF clock period. Timer compare register 11 uses four sets of start and stop registers to control the ADC conversion signal, as shown in Figure 47.

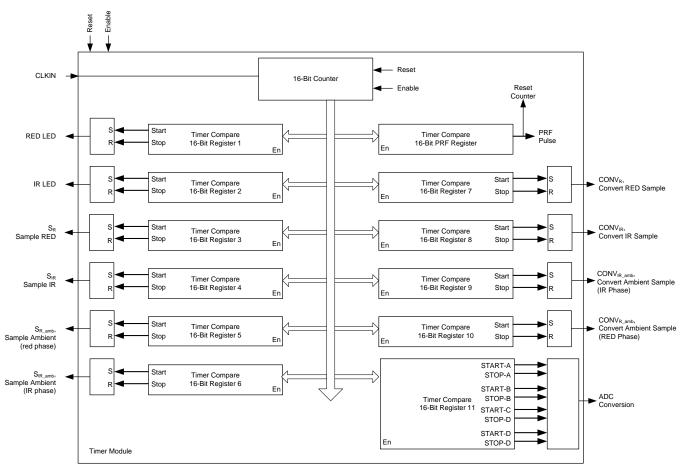


Figure 47. Timer Module

#### 8.3.3.1 Using the Timer Module

The timer module registers can be used to program the start and end instants in units of 4-MHz clock cycles. These timing instants and the corresponding registers are listed in Table 2.



Note that the device does not restrict the values in these registers; thus, the start and end edges can be positioned anywhere within the pulse repetition period. Care must be taken by the user to program suitable values in these registers to avoid overlapping the signals and to make sure none of the edges exceed the value programmed in the PRP register. Writing the same value in the start and end registers results in a pulse duration of one clock cycle. The following steps describe the timer sequencing configuration:

- 1. With respect to the start of the PRP period (indicated by timing instant  $t_0$  in Figure 48), the following sequence of conversions must be followed in order: convert LED2  $\rightarrow$  LED2 ambient  $\rightarrow$  LED1  $\rightarrow$  LED1 ambient.
- 2. Also, starting from  $t_0$ , the sequence of sampling instants must be staggered with respect to the respective conversions as follows: sample LED2 ambient  $\rightarrow$  LED1  $\rightarrow$  LED1 ambient  $\rightarrow$  LED2.
- 3. Finally, align the edges for the two LED pulses with the respective sampling instants.

Table 2. Clock Edge Mapping to SPI Registers

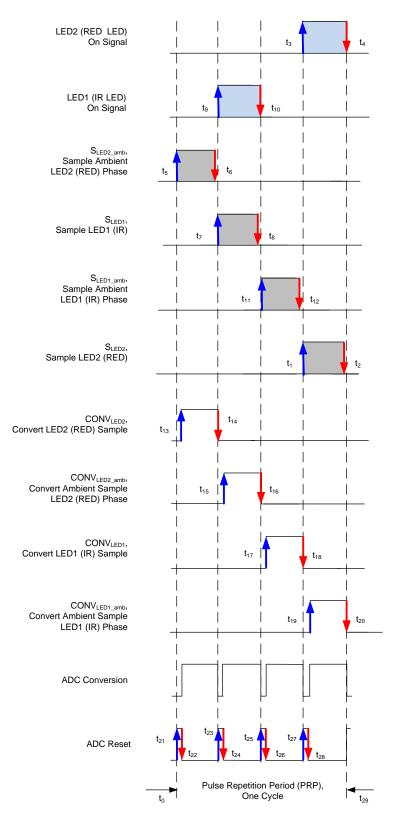
t <sub>0</sub> Start of pulse repetition period         No register control         —           t <sub>1</sub> Start of sample LED2 pulse         LED2STC(15:0), register 01h         6050           t <sub>2</sub> End of sample LED2 pulse         LED2ENDC(15:0), register 02h         7998           t <sub>3</sub> Start of LED2 pulse         LED2LEDSTC(15:0), register 03h         6000           t <sub>4</sub> End of LED2 pulse         LED2LEDSTC(15:0), register 04h         7999           t <sub>5</sub> Start of sample LED2 ambient pulse         ALED2STC(15:0), register 06h         1998           t <sub>5</sub> Start of sample LED1 pulse         LED1ENDC(15:0), register 06h         1998           t <sub>7</sub> Start of sample LED1 pulse         LED1ENDC(15:0), register 07h         2050           t <sub>8</sub> End of sample LED1 pulse         LED1ENDC(15:0), register 07h         2050           t <sub>8</sub> End of LED1 pulse         LED1ENDC(15:0), register 07h         3998           t <sub>9</sub> Start of LED1 pulse         LED1ENDC(15:0), register 08h         3998           t <sub>10</sub> End of Sample LED1 ambient pulse         ALED1ENDC(15:0), register 08h         4050           t <sub>12</sub> End of sample LED2 ambient pulse         ALED1ENDC(15:0), register 08h         4050           t <sub>13</sub> Start of convert LED2 puls	TIME INSTANT (See Figure 48 and Figure 49) <sup>(1)</sup>	DESCRIPTION	CORRESPONDING REGISTER ADDRESS AND REGISTER BITS	EXAMPLE <sup>(2)</sup> (Decimal)
t <sub>2</sub> End of sample LED2 pulse         LED2ENDC[15:0], register 02h         7998           t <sub>3</sub> Start of LED2 pulse         LED2LEDSTC[15:0], register 03h         6000           t <sub>4</sub> End of LED2 pulse         LED2LEDENDC[15:0], register 04h         7999           t <sub>5</sub> Start of sample LED2 ambient pulse         ALED2STC[15:0], register 05h         50           t <sub>6</sub> End of sample LED1 ambient pulse         ALED2STC[15:0], register 06h         1998           t <sub>7</sub> Start of sample LED1 pulse         LED1STC[15:0], register 07h         2050           t <sub>8</sub> End of sample LED1 pulse         LED1STC[15:0], register 08h         3998           t <sub>9</sub> Start of LED1 pulse         LED1EDSTC[15:0], register 08h         3998           t <sub>10</sub> End of LED1 pulse         LED1LEDSTC[15:0], register 08h         3998           t <sub>11</sub> Start of End of LED1 ambient pulse         LED1LEDSTC[15:0], register 08h         4050           t <sub>12</sub> End of Sample LED1 ambient pulse         ALED1STC[15:0], register 0Ch         5998           t <sub>13</sub> Start of convert LED2 pulse         LED2CONVST[15:0], register 0Dh         4           Must stard of each sample LED1 ambient pulse         LED2CONVST[15:0], register 0Dh         4           t <sub>15</sub> Start of conve	t <sub>o</sub>	Start of pulse repetition period	No register control	_
t <sub>3</sub> Start of LED2 pulse         LED2LEDSTC[15:0], register 03h         6000           t <sub>4</sub> End of LED2 pulse         LED2LEDENDC[15:0], register 04h         7999           t <sub>5</sub> Start of sample LED2 ambient pulse         ALED2STC[15:0], register 05h         50           t <sub>6</sub> End of sample LED2 ambient pulse         ALED2ENDC[15:0], register 06h         1998           t <sub>7</sub> Start of sample LED1 pulse         LED1STC[15:0], register 07h         2050           t <sub>8</sub> End of sample LED1 pulse         LED1ENDC[15:0], register 08h         3998           t <sub>9</sub> Start of LED1 pulse         LED1ENDC[15:0], register 08h         2000           t <sub>10</sub> End of LED1 pulse         LED1LEDENDC[15:0], register 0Ah         3999           t <sub>11</sub> Start of sample LED1 ambient pulse         ALED1STC[15:0], register 0Bh         4050           t <sub>12</sub> End of sample LED1 ambient pulse         ALED1STC[15:0], register 0Ch         5998           t <sub>13</sub> Start of convert LED2 pulse         LED2CONVST[15:0], register 0Dh         4           t <sub>14</sub> End of convert LED2 pulse         LED2CONVST[15:0], register 0Fh         1999           t <sub>15</sub> Start of convert LED2 ambient pulse         ALED2CONVST[15:0], register 16h         3999           t <sub>16</sub>	t <sub>1</sub>	Start of sample LED2 pulse	LED2STC[15:0], register 01h	6050
t <sub>4</sub> End of LED2 pulse         LED2LEDENDC(15:0), register 04h         7999           t <sub>5</sub> Start of sample LED2 ambient pulse         ALED2STC(15:0), register 05h         50           t <sub>6</sub> End of sample LED2 ambient pulse         ALED2ENDC(15:0), register 06h         1998           t <sub>7</sub> Start of sample LED1 pulse         LED1STC(15:0), register 07h         2050           t <sub>8</sub> End of sample LED1 pulse         LED1ENDC(15:0), register 08h         3998           t <sub>9</sub> Start of LED1 pulse         LED1EDENDC(15:0), register 09h         2000           t <sub>10</sub> End of LED1 pulse         LED1EDENDC(15:0), register 0Ah         3999           t <sub>11</sub> Start of sample LED1 ambient pulse         ALED1STC(15:0), register 0Bh         4050           t <sub>12</sub> End of sample LED1 ambient pulse         ALED1ENDC(15:0), register 0Dh         5998           t <sub>13</sub> Start of convert LED2 pulse         LED2CONVST(15:0), register 0Dh         4           t <sub>14</sub> End of convert LED2 pulse         LED2CONVST(15:0), register 0Fh         1999           t <sub>15</sub> Start of convert LED2 ambient pulse         ALED2CONVST(15:0), register 0Fh         3999           t <sub>16</sub> End of convert LED1 pulse         ALED2CONVST(15:0), register 10h         3999           t <sub>17</sub>	t <sub>2</sub>	End of sample LED2 pulse	LED2ENDC[15:0], register 02h	7998
t <sub>5</sub> Start of sample LED2 ambient pulse ALED2STC[15:0], register 05h 50  t <sub>6</sub> End of sample LED2 ambient pulse ALED2ENDC[15:0], register 06h 1998 t <sub>7</sub> Start of sample LED1 pulse LED1ENDC[15:0], register 07h 2050 t <sub>8</sub> End of sample LED1 pulse LED1ENDC[15:0], register 08h 3998 t <sub>9</sub> Start of LED1 pulse LED1EDDC[15:0], register 09h 2000 t <sub>10</sub> End of LED1 pulse LED1LEDSTC[15:0], register 08h 3999 t <sub>11</sub> Start of sample LED1 ambient pulse ALED1EDDC[15:0], register 0Ah 3999 t <sub>11</sub> Start of sample LED1 ambient pulse ALED1STC[15:0], register 0Bh 4050 t <sub>12</sub> End of sample LED1 ambient pulse ALED1STC[15:0], register 0Ch 5998 t <sub>13</sub> Start of convert LED2 pulse LED2CONVST[15:0], register 0Ch 5998 t <sub>14</sub> End of convert LED2 pulse LED2CONVST[15:0], register 0Ch 1999 t <sub>15</sub> Start of convert LED2 ambient pulse ALED2CONVST[15:0], register 0Ch 1999 t <sub>15</sub> Start of convert LED2 ambient pulse ALED2CONVST[15:0], register 0Ch 1999 t <sub>15</sub> Start of convert LED2 ambient pulse ALED2CONVST[15:0], register 0Ch 1999 t <sub>16</sub> Start of convert LED2 ambient pulse ALED2CONVST[15:0], register 0Ch 1999 t <sub>17</sub> Start of convert LED1 pulse ALED2CONVST[15:0], register 10h 1999 t <sub>17</sub> Start of convert LED1 pulse ALED2CONVST[15:0], register 10h 1999 t <sub>18</sub> Start of convert LED1 pulse ALED2CONVST[15:0], register 10h 1999 t <sub>19</sub> Start of convert LED1 ambient pulse ALED2CONVST[15:0], register 11h 1999 t <sub>19</sub> Start of convert LED1 ambient pulse ALED1CONVST[15:0], register 12h 1999 t <sub>20</sub> End of convert LED1 ambient pulse ALED1CONVST[15:0], register 13h 1999 t <sub>21</sub> Start of second ADC conversion reset pulse ADCRSTSTCT0[15:0], register 15h 1909 t <sub>24</sub> End of second ADC conversion reset pulse ADCRSTSTCT1[15:0], register 15h 1909 t <sub>25</sub> Start of second ADC conversion reset pulse ADCRSTSTCT1[15:0], register 18h 1900 t <sub>26</sub> End of third ADC conversion reset pulse ADCRSTSTCT2[15:0], register 18h 1900 t <sub>26</sub> End of third ADC conversion reset pulse ADCRSTSTCT3[15:0], register 18h 1900 t <sub>27</sub> Start of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 16h 1900 t <sub>28</sub> End of four	t <sub>3</sub>	Start of LED2 pulse	LED2LEDSTC[15:0], register 03h	6000
t6         End of sample LED2 ambient pulse         ALEDZENDC[15:0], register 06h         1998           t7         Start of sample LED1 pulse         LED1STC[15:0], register 07h         2050           t8         End of sample LED1 pulse         LED1ENDC[15:0], register 08h         3998           t9         Start of LED1 pulse         LED1LEDSTC[15:0], register 09h         2000           t10         End of LED1 pulse         LED1LEDSTC[15:0], register 0Ah         3999           t11         Start of sample LED1 ambient pulse         ALED1STC[15:0], register 0Bh         4050           t12         End of sample LED1 ambient pulse         ALED1ENDC[15:0], register 0Ch         5998           t13         Start of convert LED2 pulse         LED2CONVST[15:0], register 0Ch         5998           t14         End of convert LED2 pulse         LED2CONVST[15:0], register 0Ch         1999           t15         Start of convert LED2 ambient pulse         ALED2CONVST[15:0], register 0Fh         1999           t16         End of convert LED2 ambient pulse         ALED2CONVST[15:0], register 0Fh         2004           t17         Start of convert LED1 pulse         LED1CONVST[15:0], register 10h         3999           t19         Start of convert LED1 ambient pulse         ALED1CONVST[15:0], register 10h         3999           t19	t <sub>4</sub>	End of LED2 pulse	LED2LEDENDC[15:0], register 04h	7999
ty         Start of sample LED1 pulse         LED1STC[15:0], register 07h         2050           t <sub>8</sub> End of sample LED1 pulse         LED1ENDC[15:0], register 08h         3998           t <sub>9</sub> Start of LED1 pulse         LED1LEDSTC[15:0], register 08h         2000           t <sub>10</sub> End of LED1 pulse         LED1LEDSTC[15:0], register 08h         3999           t <sub>11</sub> Start of sample LED1 ambient pulse         ALED1STC[15:0], register 0Bh         4050           t <sub>12</sub> End of sample LED1 ambient pulse         ALED1ENDC[15:0], register 0Ch         5998           t <sub>13</sub> Start of convert LED2 pulse         LED2CONVST[15:0], register 0Dh         4           Must start one AFE clock cycle after the ADC reset pulse ends.         4           t <sub>14</sub> End of convert LED2 ambient pulse         ALED2CONVST[15:0], register 0Fh         1999           t <sub>15</sub> Start of convert LED2 ambient pulse         ALED2CONVST[15:0], register 10h         3999           t <sub>17</sub> Start of convert LED1 pulse         LED1CONVST[15:0], register 10h         3999           t <sub>17</sub> Start of convert LED1 pulse         LED1CONVST[15:0], register 11h         4004           t <sub>18</sub> End of convert LED1 ambient pulse         ALED1CONVEND[15:0], register 12h         5999           t <sub>19</sub>	t <sub>5</sub>	Start of sample LED2 ambient pulse	ALED2STC[15:0], register 05h	50
ts         End of sample LED1 pulse         LED1ENDC[15:0], register 08h         3998           ts         Start of LED1 pulse         LED1LEDSTC[15:0], register 09h         2000           ts         End of LED1 pulse         LED1LEDSTC[15:0], register 09h         2000           ts         End of LED1 pulse         LED1LEDENDC[15:0], register 0Ah         3999           ts         Start of sample LED1 ambient pulse         ALED1STC[15:0], register 0Bh         4050           ts         End of sample LED1 ambient pulse         ALED1SNC[15:0], register 0Dh         5998           ts         Start of convert LED2 pulse         LED2CONVST[15:0], register 0Dh         4           ts         But of convert LED2 pulse         LED2CONVST[15:0], register 0Bh         1999           ts         Start of convert LED2 pulse         LED2CONVST[15:0], register 0Bh         1999           ts         Start of convert LED2 ambient pulse         ALED2CONVST[15:0], register 0Bh         1999           ts         Start of convert LED1 pulse         LED1CONVST[15:0], register 10h         3999           ts         Start of convert LED1 pulse         LED1CONVST[15:0], register 11h         4004           ts         But of convert LED1 ambient pulse         LED1CONVST[15:0], register 12h         5999           ts         Start of irist	t <sub>6</sub>	End of sample LED2 ambient pulse	ALED2ENDC[15:0], register 06h	1998
t <sub>9</sub> Start of LED1 pulse LED1LEDSTC[15:0], register 09h 2000 t <sub>10</sub> End of LED1 pulse LED1 ambient pulse LED1LEDENDC[15:0], register 0Ah 3999 t <sub>11</sub> Start of sample LED1 ambient pulse ALED1STC[15:0], register 0Bh 4050 t <sub>12</sub> End of sample LED1 ambient pulse ALED1ENDC[15:0], register 0Bh 4050 t <sub>13</sub> Start of convert LED2 pulse LED2CONVST[15:0], register 0Dh 4000 LED2CONVST[15:0], register 10Dh 4000 LED2CONVST[15:0], register 10Dh 4000 LED2CONVST[15:0], register 10Dh 4000 LED2CONVST[15:0], register 10Dh 4000 LED2CONVST[15:0], register 11Dh 4000 LED1CONVST[15:0], register 12Dh 4000 LED1CONVST[15:0], register 12Dh 4000 LED1CONVST[15:0], register 12Dh 4000 LED1CONVST[15:0], register 15Dh 4000	t <sub>7</sub>	Start of sample LED1 pulse	LED1STC[15:0], register 07h	2050
tito End of LED1 pulse LED1ambient pulse ALED1STC[15:0], register 0Ah 3999  tit Start of sample LED1 ambient pulse ALED1STC[15:0], register 0Bh 4050  tit End of sample LED1 ambient pulse ALED1STC[15:0], register 0Ch 5998  tit Start of convert LED2 pulse LED2CONVST[15:0], register 0Ch 4  tit End of convert LED2 pulse LED2CONVST[15:0], register 0Ch 4  tit End of convert LED2 pulse LED2CONVST[15:0], register 0Ch 1999  tit Start of convert LED2 ambient pulse ALED2CONVST[15:0], register 0Ch 1999  tit Start of convert LED2 ambient pulse ALED2CONVST[15:0], register 0Ch 1999  tit End of convert LED2 ambient pulse ALED2CONVST[15:0], register 0Ch 1999  tit End of convert LED2 ambient pulse ALED2CONVST[15:0], register 10Ch 1999  tit End of convert LED1 pulse ALED2CONVST[15:0], register 11Ch 1999  tit End of convert LED1 pulse LED1CONVST[15:0], register 11Ch 1999  tit End of convert LED1 pulse LED1CONVST[15:0], register 11Ch 1999  tit End of convert LED1 ambient pulse ALED1CONVST[15:0], register 12Ch 1999  tit Start of convert LED1 ambient pulse ALED1CONVST[15:0], register 12Ch 1999  tit Start of convert LED1 ambient pulse ALED1CONVST[15:0], register 13Ch 1999  tit Start of first ADC conversion reset pulse ADCRSTSTCT0[15:0], register 14Ch 1999  tit Start of second ADC conversion reset pulse ADCRSTSTCT0[15:0], register 15Ch 1999  tit End of second ADC conversion reset pulse ADCRSTSTCT1[15:0], register 16Ch 1999  tit End of third ADC conversion reset pulse ADCRSTSTCT1[15:0], register 19Ch 1990  tit End of third ADC conversion reset pulse ADCRSTSTCT2[15:0], register 19Ch 1990  tit End of third ADC conversion reset pulse ADCRSTSTCT2[15:0], register 19Ch 1990  tit End of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 19Ch 1990  tit End of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 19Ch 1990  tit End of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 19Ch 1990  tit End of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 10Ch 1990  tit End of fourth ADC conversion reset	t <sub>8</sub>	End of sample LED1 pulse	LED1ENDC[15:0], register 08h	3998
till Start of sample LED1 ambient pulse ALED1STC[15:0], register OBh 4050  till End of sample LED1 ambient pulse ALED1ENDC[15:0], register OCh 5998  till Start of convert LED2 pulse LED2CONVST[15:0], register ODh Must start one AFE clock cycle after the ADC reset pulse ends. 4  till End of convert LED2 pulse LED2CONVST[15:0], register OBh Must start one AFE clock cycle after the ADC reset pulse ends. 4  till End of convert LED2 ambient pulse ALED2CONVST[15:0], register OBh Must start one AFE clock cycle after the ADC reset pulse ends. 2004  till End of convert LED2 ambient pulse ALED2CONVST[15:0], register 10h 3999  till Start of convert LED1 pulse LED1CONVST[15:0], register 11h Must start one AFE clock cycle after the ADC reset pulse ends. 4004  till End of convert LED1 pulse LED1CONVST[15:0], register 13h Must start one AFE clock cycle after the ADC reset pulse ends. 4004  till End of convert LED1 ambient pulse ALED1CONVST[15:0], register 13h Must start one AFE clock cycle after the ADC reset pulse ends. 6004  till Start of convert LED1 ambient pulse ALED1CONVST[15:0], register 13h Must start one AFE clock cycle after the ADC reset pulse ends. 6004  till Start of convert LED1 ambient pulse ALED1CONVEND[15:0], register 14h 7999  till Start of first ADC conversion reset pulse ADCRSTSTCT0[15:0], register 15h 0  till Start of second ADC conversion reset pulse ADCRSTSTCT0[15:0], register 16h 3  till Start of second ADC conversion reset pulse ADCRSTSTCT1[15:0], register 17h 2000  till End of second ADC conversion reset pulse ADCRSTSTCT1[15:0], register 18h 2003  till End of third ADC conversion reset pulse ADCRSTSTCT2[15:0], register 18h 4000  till End of second ADC conversion reset pulse ADCRSTSTCT2[15:0], register 18h 4000  till End of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 18h 4000  till End of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 18h 4000  till End of fourth ADC conversion reset pulse ADCRSTSTCT3[15:0], register 16h 4000  till End of fourth ADC conversion reset pu	t <sub>9</sub>	Start of LED1 pulse	LED1LEDSTC[15:0], register 09h	2000
t <sub>12</sub> End of sample LED1 ambient pulse ALED1ENDC[15:0], register OCh 5998  t <sub>13</sub> Start of convert LED2 pulse LED2CONVST[15:0], register ODh Must start one AFE clock cycle after the ADC reset pulse ends. 4  t <sub>14</sub> End of convert LED2 pulse LED2CONVEND[15:0], register OBh Must start one AFE clock cycle after the ADC reset pulse ends. 2004  t <sub>15</sub> Start of convert LED2 ambient pulse ALED2CONVEND[15:0], register OBh Must start one AFE clock cycle after the ADC reset pulse ends. 2004  t <sub>16</sub> End of convert LED2 ambient pulse ALED2CONVEND[15:0], register 10h 3999  t <sub>17</sub> Start of convert LED1 pulse LED1CONVST[15:0], register 11h Must start one AFE clock cycle after the ADC reset pulse ends. 4004  t <sub>18</sub> End of convert LED1 pulse LED1CONVSD[15:0], register 12h Must start one AFE clock cycle after the ADC reset pulse ends. 4004  t <sub>18</sub> Start of convert LED1 ambient pulse ALED1CONVST[15:0], register 13h Must start one AFE clock cycle after the ADC reset pulse ends. 6004  t <sub>20</sub> End of convert LED1 ambient pulse ALED1CONVST[15:0], register 13h Must start one AFE clock cycle after the ADC reset pulse ends. 6004  t <sub>20</sub> End of convert LED1 ambient pulse ALED1CONVSD[15:0], register 14h 7999  t <sub>21</sub> Start of first ADC conversion reset pulse ADCRSTSTCT[15:0], register 15h 0  t <sub>22</sub> End of first ADC conversion reset pulse ADCRSTSTCT[15:0], register 16h 3  t <sub>23</sub> Start of second ADC conversion reset pulse ADCRSTSTCT[15:0], register 18h 2003  t <sub>26</sub> Start of third ADC conversion reset pulse ADCRSTSTCT[15:0], register 19h 4000  t <sub>26</sub> End of third ADC conversion reset pulse ADCRSTSTCT[15:0], register 18h 6000  t <sub>26</sub> End of fourth ADC conversion reset pulse ADCRSTSTCT[15:0], register 1Bh 6000  t <sub>28</sub> End of fourth ADC conversion reset pulse ADCRSTSTCD[15:0], register 1Bh 6000	t <sub>10</sub>	End of LED1 pulse	LED1LEDENDC[15:0], register 0Ah	3999
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	t <sub>27</sub>	Start of fourth ADC conversion reset pulse	ADCRSTSTCT3[15:0], register 1Bh	6000
t <sub>29</sub> End of pulse repetition period PRPCOUNT[15:0], register 1Dh 7999	t <sub>28</sub>	End of fourth ADC conversion reset pulse (3)	ADCRSTENDCT3[15:0], register 1Ch	6003
	t <sub>29</sub>	End of pulse repetition period	PRPCOUNT[15:0], register 1Dh	7999

<sup>(1)</sup> Any pulse can be set to zero width by making its start value higher than the end value.

<sup>(2)</sup> Values are based off of a pulse repetition frequency (PRF) = 500 Hz and duty cycle = 25%.

<sup>(3)</sup> See Figure 49, note 2 for the effect of the ADC reset time crosstalk.



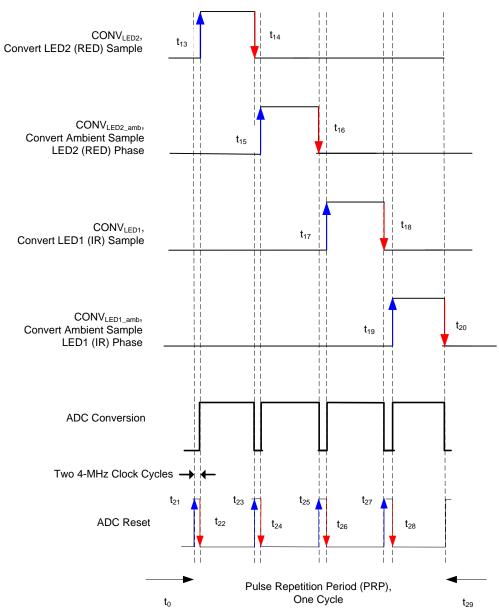


<sup>(1)</sup> RED = LED2, IR = LED1.

Figure 48. Programmable Clock Edges<sup>(1)(2)</sup>

<sup>(2)</sup> A low ADC reset time can result in a small component of the LED signal leaking into the ambient phase. With an ADC reset of two clock cycles, a -60-dB leakage is expected. In many cases, this leakage does not affect system performance. However, if this crosstalk must be completely eliminated, a longer ADC reset time of approximately six clock cycles is recommended for  $t_{22}$ ,  $t_{24}$ ,  $t_{26}$ , and  $t_{28}$ .





<sup>(1)</sup> RED = LED2, IR = LED1.

Figure 49. Relationship Between the ADC Reset and ADC Conversion Signals<sup>(1)(2)</sup>

<sup>(2)</sup> A low ADC reset time can result in a small component of the LED signal leaking into the ambient phase. With an ADC reset of two clock cycles, a -60-dB leakage is expected. In many cases, this leakage does not affect system performance. However, if this crosstalk must be completely eliminated, a longer ADC reset time of approximately six clock cycles is recommended for  $t_{22}$ ,  $t_{24}$ ,  $t_{26}$ , and  $t_{28}$ .

#### 8.3.4 Receiver Subsystem Power Path

The block diagram in Figure 50 shows the AFE4403 Rx subsystem power routing. Internal LDOs running off RX\_ANA\_SUP and RX\_DIG\_SUP generate the 1.8-V supplies required to drive the internal blocks. The two receive supplies could be shorted to a single supply on the board.

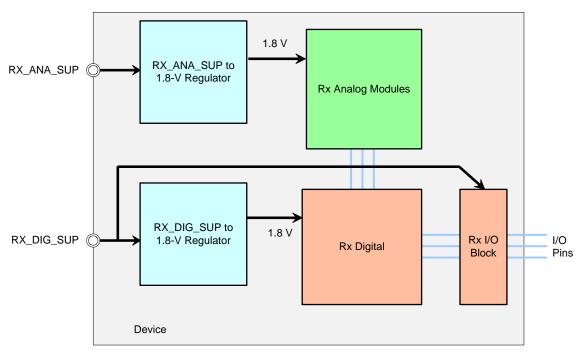


Figure 50. Receive Subsystem Power Routing

#### 8.3.5 Transmit Section

The transmit section integrates the LED driver and the LED current control section with 8-bit resolution.

The RED and IR LED reference currents can be independently set. The current source (I<sub>LED</sub>) locally regulates and ensures that the actual LED current tracks the specified reference. The transmitter section uses an internal 0.25-V reference voltage for operation. This reference voltage is available on the TX\_REF pin and must be decoupled to ground with a 2.2-µF capacitor. The TX\_REF voltage is derived from the TX\_CTRL\_SUP. The TX\_REF voltage can be programmed from 0.25 V to 1 V. A lower TX\_REF voltage allows a lower voltage to be supported on LED\_DRV\_SUP. However, the transmitter dynamic range falls in proportion to the voltage on TX\_REF. Thus, a TX\_REF setting of 0.5 V gives a 6-dB lower transmitter dynamic range as compared to a 1-V setting on TX\_REF, and a 6-dB higher transmitter dynamic range as compared to a 0.25-V setting on TX\_REF.

Note that reducing the value of the band-gap reference capacitor on the BG pin reduces the time required for the device to wake-up and settle. However, this reduction in time is a trade-off between wake-up time and noise performance. For example, reducing the value of the capacitors on the BG and TX\_REF pins from 2.2 uF to 0.1 uF reduces the wake-up time (from complete power-down) from 1000 ms to 100 ms, but results in a few decibels of degradation in the transmitter dynamic range.

The minimum LED\_DRV\_SUP voltage required for operation depends on:

- Voltage drop across the LED (V<sub>LED</sub>),
- Voltage drop across the external cable, connector, and any other component in series with the LED (V<sub>CABLE</sub>), and
- Transmitter reference voltage.

See the Recommended Operating Conditions table for further details.

Two LED driver schemes are supported:

- An H-bridge drive for a two-terminal back-to-back LED package; see Figure 51.
- A push-pull drive for a three-terminal LED package; see Figure 52.

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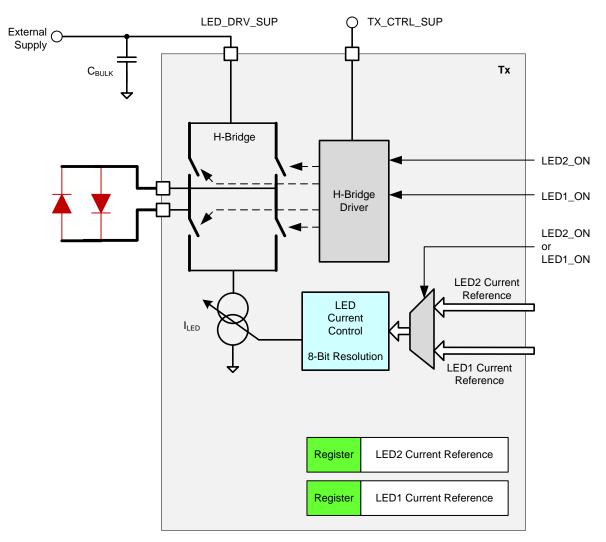


Figure 51. Transmit: H-Bridge Drive

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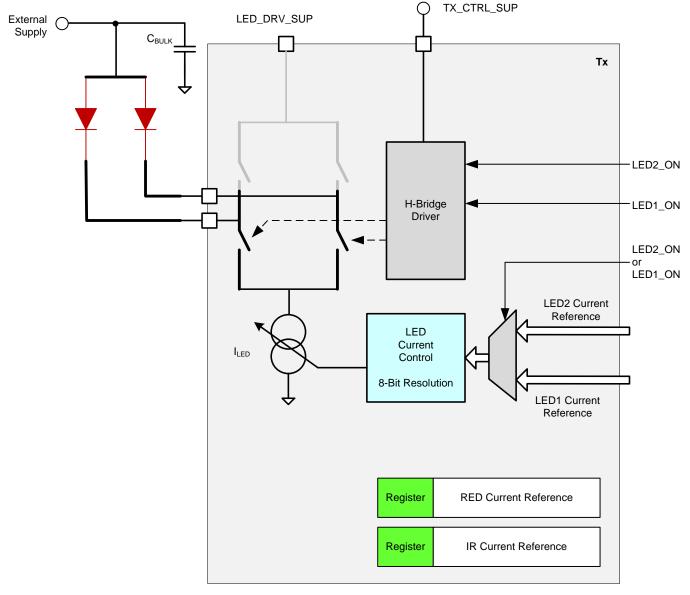


Figure 52. Transmit: Push-Pull LED Drive for Common Anode LED Configuration



#### 8.3.5.1 Third LED Support

A third LED can be optionally connected on the TX3 pin, as shown in Figure 53. An example application involving a third LED is where the Red and IR LEDs are connected on the TXP, TXN pins for pulse oximeter applications and a third LED (for example a Green LED) is connected on the TX3 pin for a heart rate monitoring application. The third LED can be connected only in common anode configuration. By programming the TX3\_MODE register bit, the timing engine controls on TXP can be transferred to the TX3 pin. In this mode, the register bits that indicate the diagnostic results on the TXP pin now indicate the diagnostic results on the TX3 pin. The selection between using TX3 versus using TXP, TXN is intended as a static mode selection as opposed to a dynamic switching selection. A typical time delay of approximately 20 ms is required for the receive channel to settle after a change to the TX3\_MODE setting. During this transition time, the receive signal chain should be active so that the filters are able to settle to the new signal level from the third LED.

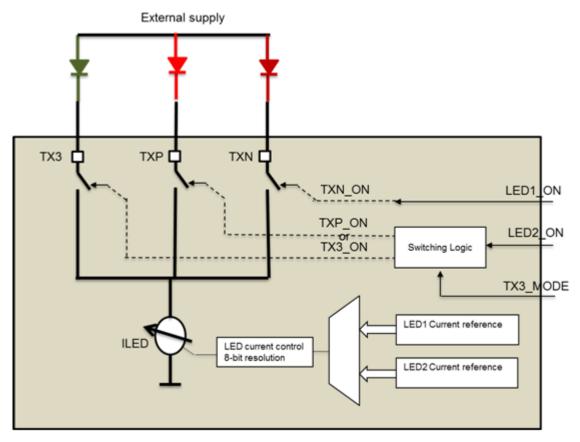


Figure 53. Multiplexing Third LED

#### 8.3.5.2 Transmitter Power Path

The block diagram in Figure 54 shows the AFE4403 Tx subsystem power routing.

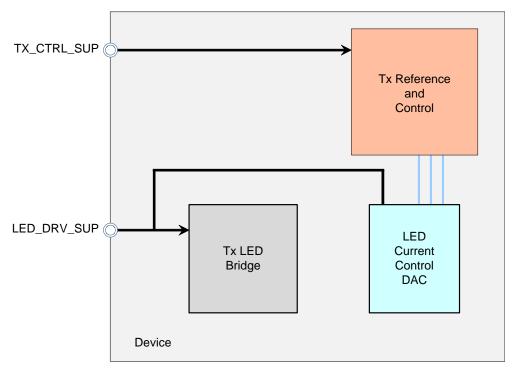


Figure 54. Transmit Subsystem Power Routing

# 8.3.5.3 LED Power Reduction During Periods of Inactivity

The diagram in Figure 55 shows how LED bias current passes 50  $\mu$ A whenever LED\_ON occurs. In order to minimize power consumption in periods of inactivity, the LED\_ON control must be turned off. Furthermore, the TIMEREN bit in the CONTROL1 register should be disabled by setting the value to 0.

Note that depending on the LEDs used, the LED may sometimes appear dimly lit even when the LED current is set to 0 mA. This appearance is because of the switching leakage currents (as shown in Figure 55) inherent to the timer function. The dimmed appearance does not effect the ambient light level measurement because during the ambient cycle, LED\_ON is turned off for the duration of the ambient measurement.

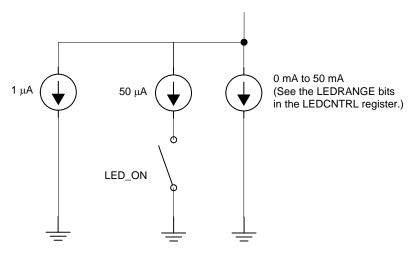


Figure 55. LED Bias Current

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### 8.3.5.4 LED Configurations

Multiple LED configurations are possible with the AFE4403.

**Case 1:** Red, IR LEDs in the common anode configuration for SPO2 and a Green LED for the HRM. Figure 56 shows the common anode configuration for this case. Figure 57 shows the configuration for HRM mode.

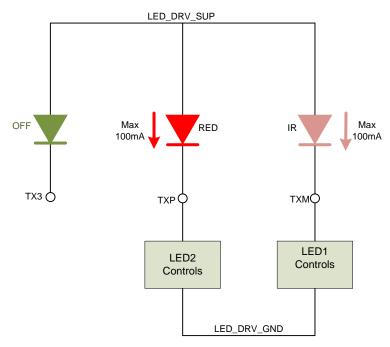


Figure 56. SPO2 Application, Common Anode Configuration

**HRM mode:** Set TX3\_MODE = 1.

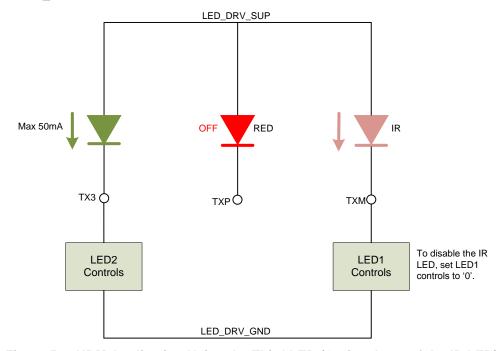


Figure 57. HRM Application Using the Third LED (Optional use of the IR LED)



**Case 2:** Red, IR LEDs in an H-bridge configuration for SPO2 and a Green LED for the HRM. The H-bridge configuration for this case is shown in Figure 58. Figure 59 shows the configuration for HRM mode.

**SPO2 mode:** Set  $TX3\_MODE = 0$ .

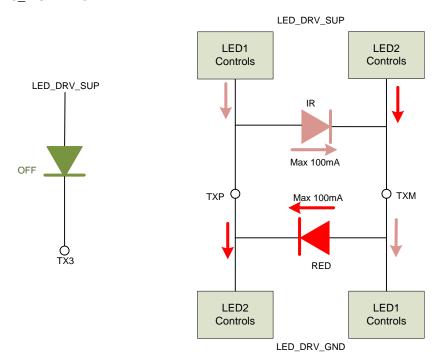


Figure 58. SPO2 Application, H-Bridge Configuration

**HRM mode:** Set TX3\_MODE = 1.

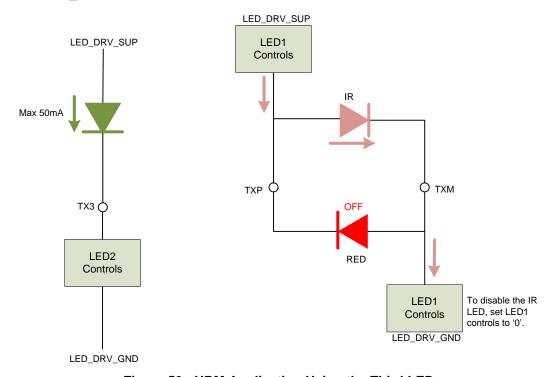


Figure 59. HRM Application Using the Third LED

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#### Case 3: Driving two LEDs simultaneously for HRM.

Some sensor modules have two LEDs on either side of the photodiode to make the illumination more uniform. The two LEDs can be connected in parallel, as shown in Figure 60.

The connection shown in Figure 60 results in an equal split of the current between the two LEDs if their forward voltages are exactly matched. High mismatch in the forward voltages of the two LEDs can cause one of them to consume the majority of the current.

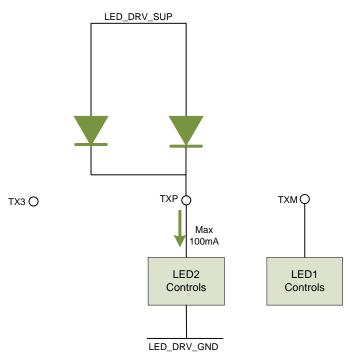


Figure 60. Using Two Parallel LEDs for an HRM Application



### Case 4: Driving two LEDs separated in time for HRM.

The two LEDs can also be driven as shown in Figure 61.

While this mode of driving the two LEDs does not drive them simultaneously, there are two advantages in this case. First, the full current is available for driving each LED. Secondly, the mismatch in the forward voltages between the two LEDs does not play a role.

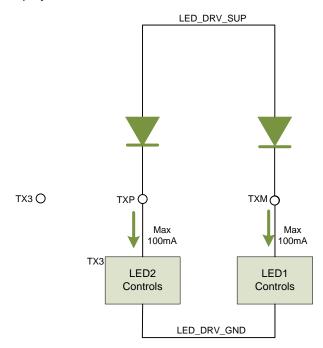


Figure 61. Using Two Parallel LEDs for an HRM Application with Separation in Timing

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#### 8.4 Device Functional Modes

### 8.4.1 ADC Operation and Averaging Module

After the falling edge of the ADC reset signal, the ADC conversion phase starts (refer to Figure 49). Each ADC conversion takes 50 µs.

The ADC operates with averaging. The averaging module averages multiple ADC samples and reduces noise to improve dynamic range. Figure 62 shows a diagram of the averaging module. The ADC output is a 22-bit code that is obtained by discarding the two MSBs of the 24-bit registers (for example the register with address 2Ah), as shown in Figure 63.

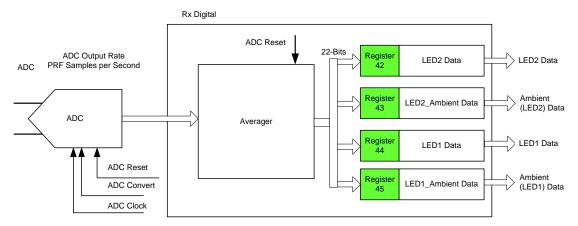


Figure 62. Averaging Module

Figure 63. 22-Bit Word

23	22	21	20	19	18	17	16	15	14	13	12
Ign	ore				22-	Bit ADC Cod	de, MSB to l	LSB			
11	10	9	8	7	6	5	4	3	2	1	0
				22-	Bit ADC Cod	de, MSB to	LSB				

Table 3 shows the mapping of the input voltage to the ADC to its output code.

**Table 3. ADC Input Voltage Mapping** 

DIFFERENTIAL INPUT VOLTAGE AT ADC INPUT	22-BIT ADC OUTPUT CODE
–1.2 V	100000000000000000000000000000000000000
(-1.2 / 2 <sup>21</sup> ) V	111111111111111111111111111111111111111
0	000000000000000000000000000000000000000
(1.2 / 2 <sup>21</sup> ) V	000000000000000000000000000000000000000
1.2 V	011111111111111111111111111111111111111

The data format is binary twos complement format, MSB-first. Because the TIA has a full-scale range of ±1 V, TI recommends that the input to the ADC does not exceed ±1 V, which is approximately 80% of its full-scale.

In cases where having the processor read the data as a 24-bit word instead of a 22-bit word is more convenient, the entire register can be mapped to the input level as shown in Figure 64.

Figure 64. 24-Bit Word

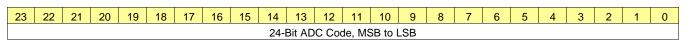




Table 4 shows the mapping of the input voltage to the ADC to its output code when the entire 24-bit word is considered.

**Table 4. Input Voltage Mapping** 

DIFFERENTIAL INPUT VOLTAGE AT ADC INPUT	24-BIT ADC OUTPUT CODE
–1.2 V	111000000000000000000000000000000000000
(-1.2 / 2 <sup>21</sup> ) V	11111111111111111111111
0	000000000000000000000000000000000000000
(1.2 / 2 <sup>21</sup> ) V	000000000000000000000000000000000000000
1.2 V	000111111111111111111111111111111111111

Now the data can be considered as a 24-bit data in binary twos complement format, MSB-first. The advantage of using the entire 24-bit word is that the ADC output is correct, even when the input is over the normal operating range.

#### 8.4.1.1 Operation Without Averaging

In this mode, the ADC outputs a digital sample one time for every 50  $\mu$ s. Consider a case where the ADC\_RDY signals are positioned at 25%, 50%, 75%, and 100% points in the pulse repetition period. At the next rising edge of the ADC reset signal, the first 22-bit conversion value is written into the result registers sequentially as follows (see Figure 65):

- At the 25% reset signal, the first 22-bit ADC sample is written to register 2Ah.
- At the 50% reset signal, the first 22-bit ADC sample is written to register 2Bh.
- At the 75% reset signal, the first 22-bit ADC sample is written to register 2Ch.
- At the next 0% reset signal, the first 22-bit ADC sample is written to register 2Dh. The contents of registers 2Ah and 2Bh are written to register 2Eh and the contents of registers 2Ch and 2Dh are written to register 2Fh.

At the rising edge of the ADC RDY signal, the contents of all six result registers can be read out.

#### 8.4.1.2 Operation With Averaging

In this mode, all ADC digital samples are accumulated and averaged after every 50  $\mu$ s. At the next rising edge of the ADC reset signal, the average value (22-bit) is written into the output registers sequentially, as follows (see Figure 66):

- At the 25% reset signal, the averaged 22-bit word is written to register 2Ah.
- At the 50% reset signal, the averaged 22-bit word is written to register 2Bh.
- At the 75% reset signal, the averaged 22-bit word is written to register 2Ch.
- At the next 0% reset signal, the averaged 22-bit word is written to register 2Dh. The contents of registers 2Ah and 2Bh are written to register 2Eh and the contents of registers 2Ch and 2Dh are written to register 2Fh.

At the rising edge of the ADC\_RDY signal, the contents of all six result registers can be read out.

The number of samples to be used per conversion phase is specified in the CONTROL1 register (NUMAV[7:0]). The user must specify the correct value for the number of averages, as described in Equation 6:

NUMAV[7:0] + 1 = 
$$\left[\frac{0.25 \times \text{Pulse Repetition Period}}{50 \, \mu \text{s}}\right] - 1 \tag{6}$$

Note that the 50-µs factor corresponds to a case where the internal clock of the AFE (after division) is exactly equal to 4 MHz. The factor scales linearly with the clock period being used.

When the number of averages is 0, the averaging is disabled and only one ADC sample is written to the result registers.

Note that the number of average conversions is limited by 25% of the PRF. For example, eight samples can be averaged with PRF = 625 Hz, and four samples can be averaged with PRF = 1250 Hz.



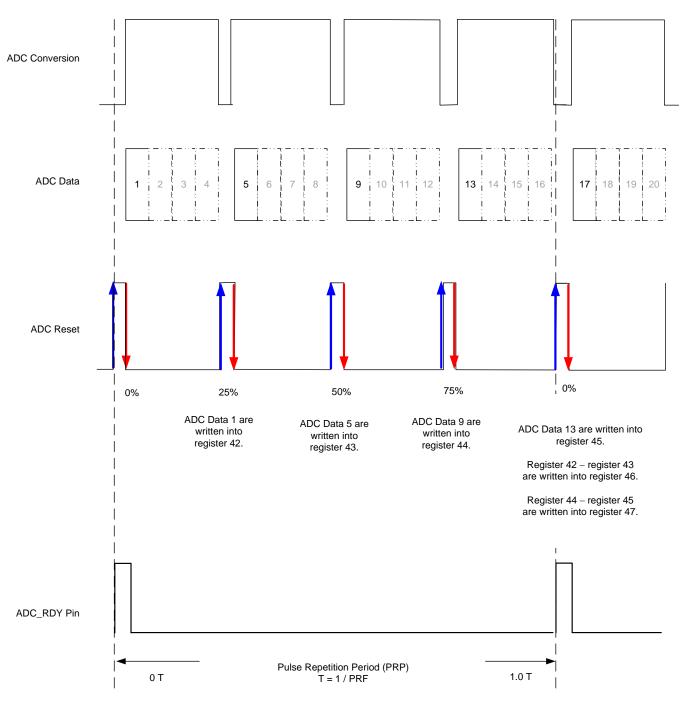
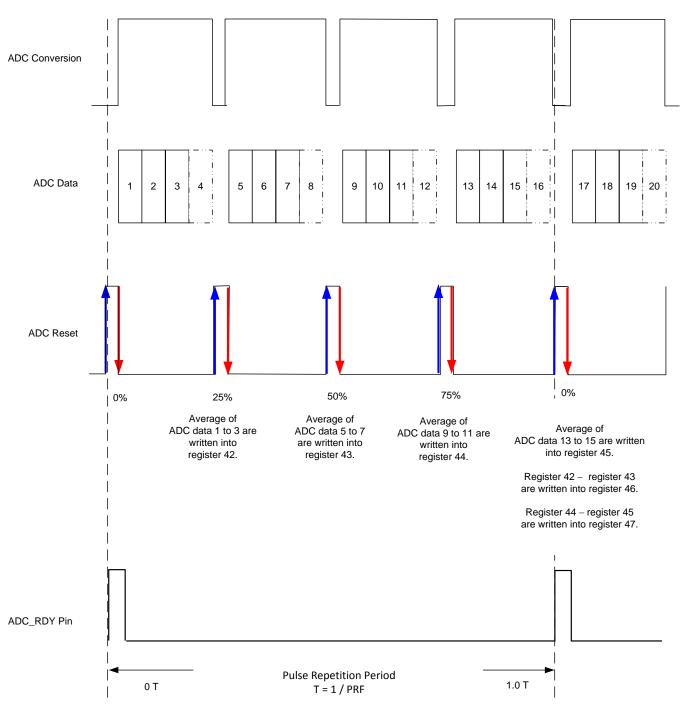


Figure 65. ADC Data Without Averaging (When Number of Averages = 0)





NOTE: Example is with three averages. The value of the NUMAVG[7:0] register bits = 2.

Figure 66. ADC Data with Averaging Enabled

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#### 8.4.1.3 Dynamic Power-Down Mode

When operated at low PRF, a dynamic power-down mode can be optionally enabled to shut off blocks during a portion of each period. This operation is illustrated in Figure 67. The dynamic power-down signal (called PDN\_CYCLE) can be internally generated using the timing controller. PDN\_CYCLE can be used to shut off power to internal blocks during the unused section within each pulse repetition period.

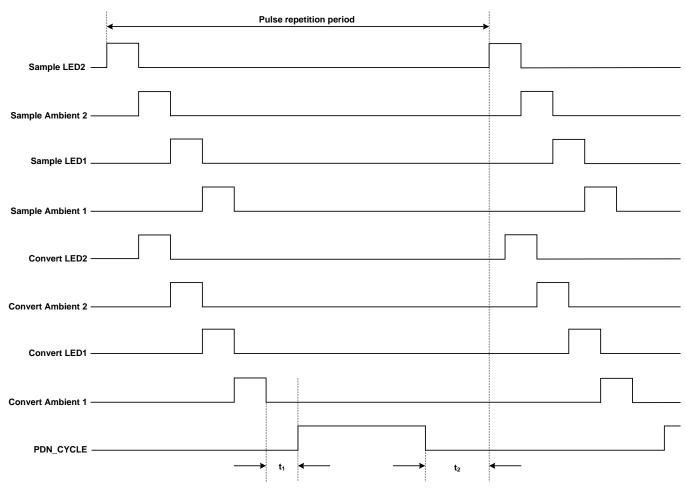


Figure 67. Dynamic Power-Down Mode Timing

 $t_1$  and  $t_2$  denote the timing margin between the active portion of the period and the dynamic power-down signal. TI recommends setting  $t_1 > 50$  µs and  $t_2 > 200$  µs in order to ensure sufficient time for the shutdown blocks to recover from power-down. By choosing the blocks that are shut down during dynamic power-down, a power savings of anywhere between 35% to 70% power can be achieved when the PDN\_CYCLE phase is active.

The sequence of the convert phases within a pulse repetition period should be as follows: LED2 (Red)  $\rightarrow$  Ambient 2  $\rightarrow$  LED1 (IR)  $\rightarrow$  Ambient 1. The sample phases must precede the corresponding convert phase. Also note that the ADC\_RDY signal comes at the beginning of the pulse repetition period. Thus, the contents of the registers must be read before the completion of the first conversion phase in the pulse repetition period. These contents correspond to the samples of the four phases from the previous pulse repetition period.

The DYNAMIC1, DYNAMIC2, DYNAMIC3, and DYNAMIC4 bits determine which blocks are powered down during the dynamic power-down state (when PDN\_CYCLE is high). For maximum power saving, all four bits can be set to 1. TI recommends setting  $t_1$  to greater than 100  $\mu$ s and  $t_2$  to greater than 200  $\mu$ s to ensure that the blocks recover from power-down in time for the next cycle.



The bit corresponding to the TIA power-down (DYNAMIC3) needs a bit more consideration. When the TIA is powered down, the TIA no longer maintains the bias across the photodiode output. This loss of bias can cause the photodiode output voltage to drift from the normal value. The recovery time constant associated with the photodiode returning to a proper bias condition (when the TIA is powered back on) is approximately equal to 2  $\times$  C<sub>PD</sub>  $\times$  R<sub>F</sub>, where C<sub>PD</sub> is the effective differential capacitance of the photodiode and R<sub>F</sub> is the TIA gain setting. This consideration might result in a different choice for the value of t<sub>2</sub>.

# 8.4.2 Diagnostics

The device includes diagnostics to detect open or short conditions of the LED and photosensor, LED current profile feedback, and cable on or off detection.

#### 8.4.2.1 Photodiode-Side Fault Detection

Figure 68 shows the diagnostic for the photodiode-side fault detection.

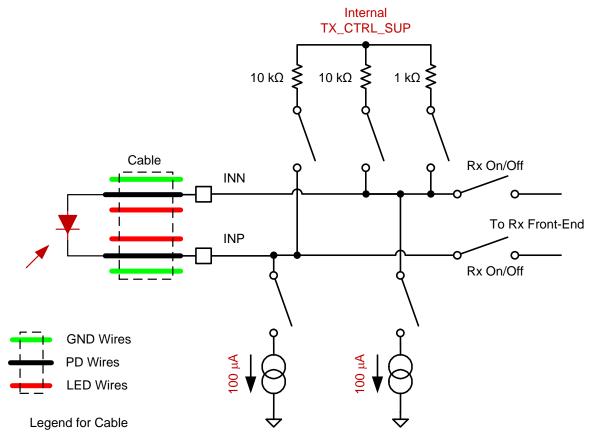


Figure 68. Photodiode Diagnostic

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# 8.4.2.2 Transmitter-Side Fault Detection

Figure 69 shows the diagnostic for the transmitter-side fault detection.

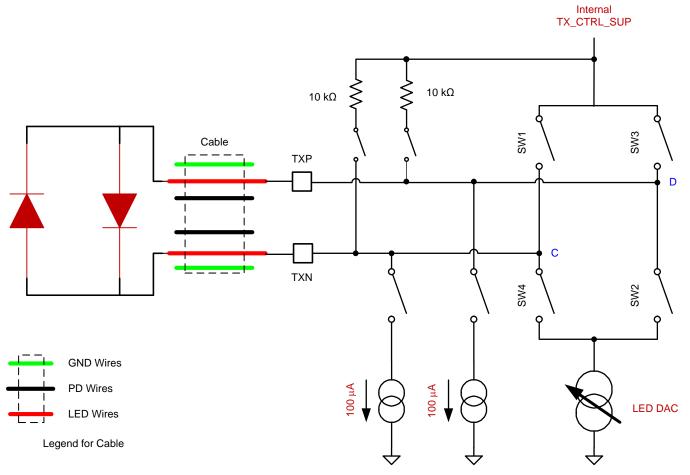


Figure 69. Transmitter Diagnostic

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# 8.4.2.3 Diagnostics Module

The diagnostics module, when enabled, checks for nine types of faults sequentially. The results of all faults are latched in 11 separate flags.

The status of all flags can also be read using the SPI interface. Table 5 details each fault and flag used. Note that the diagnostics module requires all AFE blocks to be enabled in order to function reliably.

Table 5. Fault and Flag Diagnostics<sup>(1)</sup>

MODULE	SEQ.	FAULT	FLAG1	FLAG2	FLAG3	FLAG4	FLAG5	FLAG6	FLAG7	FLAG8	FLAG9	FLAG10	FLAG11
_	_	No fault	0	0	0	0	0	0	0	0	0	0	0
	1	Rx INP cable shorted to LED cable	1										
	2	Rx INN cable shorted to LED cable		1									
PD	3	Rx INP cable shorted to GND cable			1								
	4	Rx INN cable shorted to GND cable				1							
	5	PD open or shorted					1	1					
	6	Tx OUTM line shorted to GND cable							1				
LED	7	Tx OUTP line shorted to GND cable								1			
	8	LED open or shorted									1	1	
	9	LED open or shorted											1

<sup>(1)</sup> Resistances below 10  $k\Omega$  are considered to be shorted.



Figure 70 shows the timing for the diagnostic function.

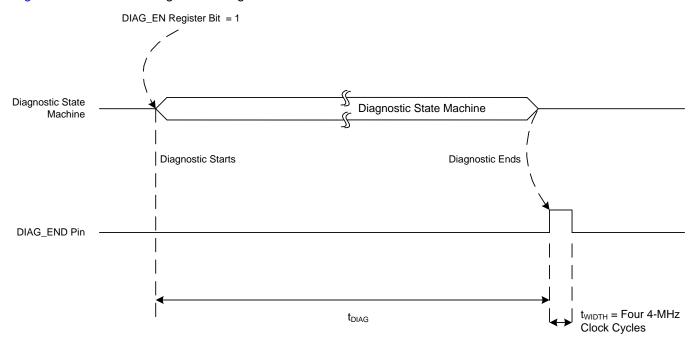


Figure 70. Diagnostic Timing Diagram

By default, the diagnostic function takes  $t_{DIAG} = 16$  ms to complete. After the diagnostics function completes, the AFE4403 filter must be allowed time to settle. See the *Electrical Characteristics* for the filter settling time.

# 8.5 Programming

#### 8.5.1 Serial Programming Interface

The SPI-compatible serial interface consists of four signals: SCLK (serial clock), SPISOMI (serial interface data output), SPISIMO (serial interface data input), and SPISTE (serial interface enable).

The serial clock (SCLK) is the serial peripheral interface (SPI) serial clock. SCLK shifts in commands and shifts out data from the device. SCLK features a Schmitt-triggered input and clocks data out on the SPISOMI. Data are clocked in on the SPISIMO pin. Even though the input has hysteresis, TI recommends keeping SCLK as clean as possible to prevent glitches from accidentally shifting the data. When the serial interface is idle, hold SCLK low.

The SPI serial out master in (SPISOMI) pin is used with SCLK to clock out the AFE4403 data. The SPI serial in master out (SPISIMO) pin is used with SCLK to clock in data to the AFE4403. The SPI serial interface enable (SPISTE) pin enables the serial interface to clock data on the SPISIMO pin in to the device.

# 8.5.2 Reading and Writing Data

The device has a set of internal registers that can be accessed by the serial programming interface formed by the SPISTE, SCLK, SPISIMO, and SPISOMI pins.

# 8.5.2.1 Writing Data

The SPI READ register bit must be first set to 0 before writing to a register. When SPISTE is low:

- Serially shifting bits into the device is enabled.
- Serial data (on the SPISIMO pin) are latched at every SCLK rising edge.
- The serial data are loaded into the register at every 32nd SCLK rising edge.



# **Programming (continued)**

In case the word length exceeds a multiple of 32 bits, the excess bits are ignored. Data can be loaded in multiples of 32-bit words within a single active SPISTE pulse. The first eight bits form the register address and the remaining 24 bits form the register data. Figure 71 shows an SPI timing diagram for a single write operation. For multiple read and write cycles, refer to the *Multiple Data Reads and Writes* section.

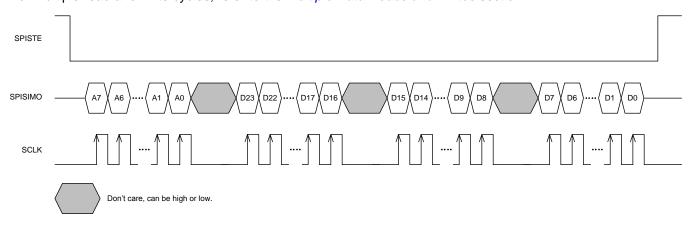


Figure 71. AFE SPI Write Timing Diagram

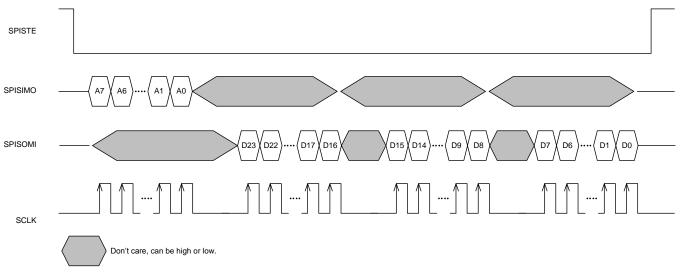
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# **Programming (continued)**

#### 8.5.2.2 Reading Data

The SPI\_READ register bit must be first set to 1 before reading from a register. The AFE4403 includes a mode where the contents of the internal registers can be read back on the SPISOMI pin. This mode may be useful as a diagnostic check to verify the serial interface communication between the external controller and the AFE. To enable this mode, first set the SPI\_READ register bit using the SPI write command, as described in the *Writing Data* section. In the next command, specify the SPI register address with the desired content to be read. Within the same SPI command sequence, the AFE outputs the contents of the specified register on the SPISOMI pin. Figure 72 shows an SPI timing diagram for a single read operation. For multiple read and write cycles, refer to the *Multiple Data Reads and Writes* section.



- (1) The SPI READ register bit must be enabled before attempting a serial readout from the AFE.
- (2) Specify the register address of the content that must be readback on bits A[7:0].
- (3) The AFE outputs the contents of the specified register on the SPISOMI pin.

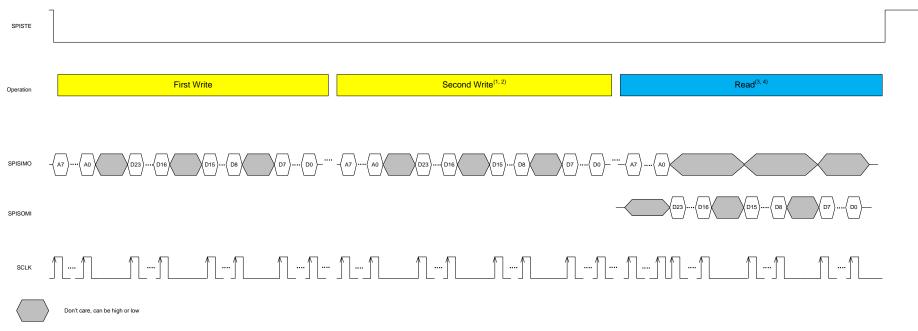
Figure 72. AFE SPI Read Timing Diagram

56



#### 8.5.2.3 Multiple Data Reads and Writes

The device includes functionality where multiple read and write operations can be performed during a single SPISTE event. To enable this functionality, the first eight bits determine the register address to be written and the remaining 24 bits determine the register data. Perform two writes with the SPI read bit enabled during the second write operation in order to prepare for the read operation, as described in the *Writing Data* section. In the next command, specify the SPI register address with the desired content to be read. Within the same SPI command sequence, the AFE outputs the contents of the specified register on the SPISOMI pin. This functionality is described in the *Writing Data* and *Reading Data* sections. Figure 73 shows a timing diagram for the SPI multiple read and write operations.



- (1) The SPI read register bit must be enabled before attempting a serial readout from the AFE.
- (2) The second write operation must be configured for register 0 with data 000001h.
- (3) Specify the register address whose contents must be read back on A[7:0].
- (4) The AFE outputs the contents of the specified register on the SPISOMI pin.

Figure 73. Serial Multiple Read and Write Operations

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### 8.5.2.4 Register Initialization

After power-up, the internal registers **must** be initialized to the default values. This initialization can be done in one of two ways:

- Through a hardware reset by applying a low-going pulse on the RESET pin, or
- By applying a software reset. Using the serial interface, set SW\_RESET (bit D3 in register 00h) high. This
  setting initializes the internal registers to the default values and then self-resets to 0. In this case, the RESET
  pin is kept high (inactive).

#### 8.5.2.5 AFE SPI Interface Design Considerations

Note that when the AFE4403 is deselected, the SPISOMI, CLKOUT, ADC\_RDY, and DIAG\_END digital output pins do not enter a 3-state mode. This condition, therefore, must be taken into account when connecting multiple devices to the SPI port and for power-management considerations. In order to avoid loading the SPI bus when multiple devices are connected, the SOMI\_TRI register bit must be to 1 whenever the AFE SPI is inactive. The DIGOUT\_TRISTATE register bit must be set to 1 to tri-state the ADC\_RDY and DIAG\_END pins. The CLKOUT TRI register bit must be set to 1 to put the CLKOUT buffer in tri-state mode.

# 8.6 Register Maps

# 8.6.1 AFE Register Map

The AFE consists of a set of registers that can be used to configure it, such as receiver timings, I-V amplifier settings, transmit LED currents, and so forth. The registers and their contents are listed in Table 6. These registers can be accessed using the AFE SPI interface.

**Table 6. AFE Register Map** 

NAME	REGISTER	ADDI	RESS												REGI	STER D	ATA										
NAME	CONTROL <sup>(1)</sup>	Hex	Dec	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CONTROL0	W	00	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	SW_RST	DIAG_EN	TIM_COUNT_RST	SPI_READ
LED2STC	R/W	01	1	0	0	0	0	0	0	0	0								LED2S	TC[15:0]							
LED2ENDC	R/W	02	2	0	0	0	0	0	0	0	0								LED2EN	IDC[15:0]							
LED2LEDSTC	R/W	03	3	0	0	0	0	0	0	0	0								LED2LED	STC[15:0]							
LED2LEDENDC	R/W	04	4	0	0	0	0	0	0	0	0 LEDZLEDSTC[15:0] 0 ALEDZSTC[15:0] 0 ALEDZSTC[15:0] 0 LED1STC[15:0] 0 LED1STC[15:0]																
ALED2STC	R/W	05	5	0	0	0	0	0	0	0	0																
ALED2ENDC	R/W	06	6	0	0	0	0	0	0	0	0																
LED1STC	R/W	07	7	0	0	0	0	0	0	0	0																
LED1ENDC	R/W	08	8	0	0	0	0	0	0	0	0 ALED2STC[15:0] 0 ALED2ENDC[15:0] 0 LED1STC[15:0] 0 LED1ENDC[15:0] 0 LED1LEDSTC[15:0] 0 LED1LEDSTC[15:0]																
LED1LEDSTC	R/W	09	9	0	0	0	0	0	0	0	0 ALED2ENDC[15:0] 0 LED1STC[15:0] 0 LED1ENDC[15:0] 0 LED1LEDSTC[15:0] 0 LED1LEDENDC[15:0]																
LED1LEDENDC	R/W	0A	10	0	0	0	0	0	0	0	0 ALED2ENDC[15:0] 0 LED1STC[15:0] 0 LED1ENDC[15:0] 0 LED1LEDSTC[15:0] 0 LED1LEDENDC[15:0]																
ALED1STC	R/W	0B	11	0	0	0	0	0	0	0	0 LED2LEDENDC[15:0] 0 ALED2STC[15:0] 0 ALED2ENDC[15:0] 0 LED1STC[15:0] 0 LED1ENDC[15:0] 0 LED1LEDSTC[15:0] 0 LED1LEDSTC[15:0]																
ALED1ENDC	R/W	0C	12	0	0	0	0	0	0	0	0 LED2LEDENDC[15:0] 0 ALED2STC[15:0] 0 ALED2ENDC[15:0] 0 LED1STC[15:0] 0 LED1ENDC[15:0] 0 LED1LEDSTC[15:0] 0 LED1LEDSTC[15:0] 0 LED1LEDENDC[15:0] 0 ALED1STC[15:0] 0 LED1LEDENDC[15:0] 0 LED1LEDENDC[15:0] 0 LED1LEDENDC[15:0] 0 LED1LEDENDC[15:0]																
LED2CONVST	R/W	0D	13	0	0	0	0	0	0	0	0							l	ED2CON	NVST[15:0]							
LED2CONVEND	R/W	0E	14	0	0	0	0	0	0	0	0							L	ED2CON	VEND[15:0	)]						
ALED2CONVST	R/W	0F	15	0	0	0	0	0	0	0	0							Д	LED2CO	NVST[15:0]	]						
ALED2CONVEND	R/W	10	16	0	0	0	0	0	0	0	0							Al	ED2CON	IVEND[15:0	0]						
LED1CONVST	R/W	11	17	0	0	0	0	0	0	0	0							ı	ED1CON	NVST[15:0]							
LED1CONVEND	R/W	12	18	0	0	0	0	0	0	0	0							L	ED1CON	VEND[15:0	)]						
ALED1CONVST	R/W	13	19	0	0	0	0	0	0	0	0							Д	LED1CO	NVST[15:0]	]						
ALED1CONVEND	R/W	14	20	0	0	0	0	0	0	0	0							Al	ED1CON	IVEND[15:0	0]						
ADCRSTSTCT0	R/W	15	21	0	0	0	0	0	0	0	0								ADCRST	CT0[15:0]							
ADCRSTENDCT0	R/W	16	22	0	0	0	0	0	0	0	0							,	ADCRENI	OCT0[15:0]							
ADCRSTSTCT1	R/W	17	23	0	0	0	0	0	0	0	0								ADCRST	CT1[15:0]							
ADCRSTENDCT1	R/W	18	24	0	0	0	0	0	0	0	0							,	ADCREN	OCT1[15:0]							
ADCRSTSTCT2	R/W	19	25	0	0	0	0	0	0	0	0								ADCRST	CT2[15:0]							
ADCRSTENDCT2	R/W	1A	26	0	0	0	0	0	0	0	0							,	ADCRENI	OCT2[15:0]							

<sup>(1)</sup> R = read only, R/W = read or write, N/A = not available, and W = write only.



# **Table 6. AFE Register Map (continued)**

	REGISTER	ADD	RESS													STER D	ATA										
NAME	CONTROL <sup>(1)</sup>	Hex	Dec	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ADCRSTSTCT3	R/W	1B	27	0	0	0	0	0	0	0	0							F	DCRST	CT3[15:0]		-					
ADCRSTENDCT3	R/W	1C	28	0	0	0	0	0	0	0	0									OCT3[15:0]							
PRPCOUNT	R/W	1D	29	0	0	0	0	0	0	0	0								PRPC	T[15:0]							
CONTROL1	R/W	1E	30	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	TIMEREN				NUM	IAV[7:0]			
SPARE1	N/A	1F	31	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
TIAGAIN	R/W	20	32	0	0	0	0	0	0	0	0	ENSEPGAN	STAGE2EN1	0	0	0	ST	G2GAIN1[	2:0]		CF_L	_ED1[4	:0]		R	F_LED1	[2:0]
TIA_AMB_GAIN	R/W	21	33	0	0	0	0		AMBD	AC[3:0]		FLTRCNRSEL	STAGE2EN	0	0	0	ST	G2GAIN2[	2:0]		CF_	LED[4:	0]		F	RF_LED[	2:0]
LEDCNTRL	R/W	22	34	0	0	0	0	0	0	2	LED_KANGE[1:0]																
CONTROL2	R/W	23	35	0	0	0	DYNAMIC1	0	TX_REF1	TX_REF0	0	0	DYNAMIC2	0	0	TXBRGMOD	DIGOUT_TRISTATE	XTALDIS	EN_SLOW_DIAG	0	0	0	DYNAMIC3	DYNAMIC4	PDNTX	PDNRX	PDNAFE
SPARE2	N/A	24	36	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
SPARE3	N/A	25	37	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
SPARE4	N/A	26	38	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
RESERVED1	N/A	27	39	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х
RESERVED2	N/A	28	40	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х	Х
ALARM	R/W	29	41	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
LED2VAL	R	2A	42		•	•									LED	2VAL[23	:0]		•	•	•						
ALED2VAL	R	2B	43												ALED	2VAL[2	3:0]										
LED1VAL	R	2C	44												LED'	1VAL[23	:0]										
ALED1VAL	R	2D	45												ALED	1VAL[2	3:0]										
LED2-ALED2VAL	R	2E	46											L	ED2-AL	ED2VA	L[23:0]										
LED1-ALED1VAL	R	2F	47											L	.ED1-AL	ED1VA	L[23:0]										

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# **Table 6. AFE Register Map (continued)**

NAME	REGISTER	ADDI	RESS												REGIS	STER D	ATA										
NAME	CONTROL <sup>(1)</sup>	Hex	Dec	23	22	21	20	19	18	17	16	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DIAG	R	30	48	0	0	0	0	0	0	0	0	0	0	0	PD_ALM	LED_ALM	LEDZOPEN	LED10PEN	LEDSC	OUTNSHGND	OUTPSHGND	PDOC	PDSC	INNSCGND	INPSCGND	INNSCLED	INPSCLED
CONTROL3	R/W	31	49	0	0	0	0	0	0	0	0	TX3_MODE	0	0	0	0	0	0	0	0	0	0	SOMI_TRI	CLKOUT_TRI	Ó	CLKDIV[2	2:0]
PDNCYCLESTC	R/W	32	50	0	0	0	0	0	0	0	0							PD	NCYCLE	ESTC[15:0	]						
PDNCYCLEENDC	R/W	33	51	0	0	0	0	0	0	0	0	PDNCYCLESTC[15:0]															



#### 8.6.2 AFE Register Description

Figure 74. CONTROL0: Control Register 0 (Address = 00h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	0	0	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	SW_RST	DIAG_EN	TIM_ COUNT_ RST	SPI_ READ

This register is write-only. CONTROL0 is used for AFE software and count timer reset, diagnostics enable, and SPI read functions.

Bits 23:4 Must be 0

Bit 3 SW\_RST: Software reset

0 = No action (default after reset)

1 = Software reset applied; resets all internal registers to the default values and self-clears

#### Bit 2 DIAG\_EN: Diagnostic enable

0 = No action (default after reset)

1 = Diagnostic mode is enabled and the diagnostics sequence starts when this bit is set. At the end of the sequence, all fault status are stored in the DIAG: Diagnostics Flag Register. Afterwards, the DIAG EN register bit self-clears to 0.

Note that the diagnostics enable bit is automatically reset after the diagnostics completes (16 ms). During the diagnostics mode, ADC data are invalid because of the toggling diagnostics switches.

#### Bit 1 TIM\_CNT\_RST: Timer counter reset

0 = Disables timer counter reset, required for normal timer operation (default after reset)

1 = Timer counters are in reset state

#### Bit 0 SPI READ: SPI read

0 = SPI read is disabled (default after reset)

1 = SPI read is enabled

Figure 75. LED2STC: Sample LED2 Start Count Register (Address = 01h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		LED2S	TC[15:0]	
11	10	9	8	7	6	5	4	3	2	1	0
					LED2S	TC[15:0]					

This register sets the start timing value for the LED2 signal sample.

#### Bits 23:16 Must be 0

#### Bits 15:0 LED2STC[15:0]: Sample LED2 start count

The contents of this register can be used to position the start of the sample LED2 signal with respect to the pulse repetition period (PRP), as specified in the PRPCOUNT register. The count is specified as the number of

4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.



Figure 76. LED2ENDC: Sample LED2 End Count Register (Address = 02h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		LED2EN	DC[15:0]	
11	10	9	8	7	6	5	4	3	2	1	0
					LED2EN	IDC[15:0]					

This register sets the end timing value for the LED2 signal sample.

Bits 23:16 Must be 0

Bits 15:0 LED2ENDC[15:0]: Sample LED2 end count

The contents of this register can be used to position the end of the sample LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 77. LED2LEDSTC: LED2 LED Start Count Register (Address = 03h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		LED2LED	STC[15:0]	
11	10	9	8	7	6	5	4	3	2	1	0
					LED2LED	STC[15:0]					

This register sets the start timing value for when the LED2 signal turns on.

Bits 23:16 Must be 0

Bits 15:0 LED2LEDSTC[15:0]: LED2 start count

The contents of this register can be used to position the start of the LED2 with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 78. LED2LEDENDC: LED2 LED End Count Register (Address = 04h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		LED2LEDE	NDC[15:0]	
11	10	9	8	7	6	5	4	3	2	1	0
					LED2LEDE	ENDC[15:0]					

This register sets the end timing value for when the LED2 signal turns off.

Bits 23:16 Must be 0

Bits 15:0 LED2LEDENDC[15:0]: LED2 end count

The contents of this register can be used to position the end of the LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.



Figure 79. ALED2STC: Sample Ambient LED2 Start Count Register (Address = 05h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12			
0	0	0	0	0	0	0	0		ALED2STC[15:0]					
11 10 9 8 7 6 5 4 3 2 1								1	0					
ALED2STC[15:0]														

This register sets the start timing value for the ambient LED2 signal sample.

Bits 23:16 Must be 0

Bits 15:0 ALED2STC[15:0]: Sample ambient LED2 start count

The contents of this register can be used to position the start of the sample ambient LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 80. ALED2ENDC: Sample Ambient LED2 End Count Register (Address = 06h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ALED2ENDC[15:0]				
11	10	9	8	7	6	5	4	3	0				
ALED2ENDC[15:0]													

This register sets the end timing value for the ambient LED2 signal sample.

Bits 23:16 Must be 0

Bits 15:0 ALED2ENDC[15:0]: Sample ambient LED2 end count

The contents of this register can be used to position the end of the sample ambient LED2 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 81. LED1STC: Sample LED1 Start Count Register (Address = 07h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		LED1STC[15:0]				
11	10	9	8	7	6	5	4	3	2	1	0		
LED1STC[15:0]													

This register sets the start timing value for the LED1 signal sample.

Bits 23:17 Must be 0

Bits 16:0 LED1STC[15:0]: Sample LED1 start count

The contents of this register can be used to position the start of the sample LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of

4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.



Figure 82. LED1ENDC: Sample LED1 End Count (Address = 08h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12			
0	0	0	0	0	0	0	0		LED1ENDC[15:0]					
11	10	9	8	7	6	5	4	3	2	1	0			
LED1ENDC[15:0]														

This register sets the end timing value for the LED1 signal sample.

Bits 23:17 Must be 0

Bits 16:0 LED1ENDC[15:0]: Sample LED1 end count

The contents of this register can be used to position the end of the sample LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of

4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 83. LED1LEDSTC: LED1 LED Start Count Register (Address = 09h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		LED1LEDSTC[15:0]				
11	10	9	8	7	6	5	4	3	0				
	LED1LEDSTC[15:0]												

This register sets the start timing value for when the LED1 signal turns on.

Bits 23:16 Must be 0

Bits 15:0 LED1LEDSTC[15:0]: LED1 start count

The contents of this register can be used to position the start of the LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 84. LED1LEDENDC: LED1 LED End Count Register (Address = 0Ah, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		LED1LEDENDC[15:0]				
11	10	9	8	7	6	5	4	3	3 2 1				
	LED1LEDENDC[15:0]												

This register sets the end timing value for when the LED1 signal turns off.

Bits 23:16 Must be 0

Bits 15:0 LED1LEDENDC[15:0]: LED1 end count

The contents of this register can be used to position the end of the LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.



Figure 85. ALED1STC: Sample Ambient LED1 Start Count Register (Address = 0Bh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12			
0	0	0	0	0	0	0	0		ALED1STC[15:0]					
11	10	9	8	7	6	5	4	3	2	1	0			
ALED1STC[15:0]														

This register sets the start timing value for the ambient LED1 signal sample.

Bits 23:16 Must be 0

Bits 15:0 ALED1STC[15:0]: Sample ambient LED1 start count

The contents of this register can be used to position the start of the sample ambient LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 86. ALED1ENDC: Sample Ambient LED1 End Count Register (Address = 0Ch, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ALED1ENDC[15:0]				
11	10	9	8	7	6	5	4	3	2 1				
	ALED1ENDC[15:0]												

This register sets the end timing value for the ambient LED1 signal sample.

Bits 23:16 Must be 0

Bits 15:0 ALED1ENDC[15:0]: Sample ambient LED1 end count

The contents of this register can be used to position the end of the sample ambient LED1 signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 87. LED2CONVST: LED2 Convert Start Count Register (Address = 0Dh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		LED2CONVST[15:0]				
11	10	9	8	7	6	5	4	3	2 1				
	LED2CONVST[15:0]												

This register sets the start timing value for the LED2 conversion.

Bits 23:16 Must be 0

Bits 15:0 LED2CONVST[15:0]: LED2 convert start count

The contents of this register can be used to position the start of the LED2 conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.



Figure 88. LED2CONVEND: LED2 Convert End Count Register (Address = 0Eh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		LED2CON\				
11	10	9	8	7	6	5	4	3	2	1	0		
	LED2CONVEND[15:0]												

This register sets the end timing value for the LED2 conversion.

Bits 23:16 Must be 0

Bits 15:0 LED2CONVEND[15:0]: LED2 convert end count

The contents of this register can be used to position the end of the LED2 conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 89. ALED2CONVST: LED2 Ambient Convert Start Count Register (Address = 0Fh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		ALED2CO		
11	10	9	8	7	6	5	4	3	2	1	0
ALED2CONVST[15:0]											

This register sets the start timing value for the ambient LED2 conversion.

Bits 23:16 Must be 0

Bits 15:0 ALED2CONVST[15:0]: LED2 ambient convert start count

The contents of this register can be used to position the start of the LED2 ambient conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 90. ALED2CONVEND: LED2 Ambient Convert End Count Register (Address = 10h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ALED2CONVEND[15:0]				
11	10	9	8	7	6	5	4	3	3 2 1				
	ALED2CONVEND[15:0]												

This register sets the end timing value for the ambient LED2 conversion.

Bits 23:16 Must be 0

#### Bits 15:0 ALED2CONVEND[15:0]: LED2 ambient convert end count

The contents of this register can be used to position the end of the LED2 ambient conversion signal with respect to the PRP. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.



Figure 91. LED1CONVST: LED1 Convert Start Count Register (Address = 11h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12	
0	0	0	0	0	0	0	0		LED1CON	IVST[15:0]		
11	10	9	8	7	6	5	4	3	2 1			
	LED1CONVST[15:0]											

This register sets the start timing value for the LED1 conversion.

Bits 23:16 Must be 0

Bits 15:0 LED1CONVST[15:0]: LED1 convert start count

The contents of this register can be used to position the start of the LED1 conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 92. LED1CONVEND: LED1 Convert End Count Register (Address = 12h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		LED1CON		
11	10	9	8	7	6	5	4	3	2	1	0
LED1CONVEND[15:0]											

This register sets the end timing value for the LED1 conversion.

Bits 23:16 Must be 0

Bits 15:0 LED1CONVEND[15:0]: LED1 convert end count

The contents of this register can be used to position the end of the LED1 conversion signal with respect to the PRP. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 93. ALED1CONVST: LED1 Ambient Convert Start Count Register (Address = 13h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ALED1CONVST[15:0]				
11	10	9	8	7	6	5	4	3	2	1	0		
	ALED1CONVST[15:0]												

This register sets the start timing value for the ambient LED1 conversion.

Bits 23:16 Must be 0

Bits 15:0 ALED1CONVST[15:0]: LED1 ambient convert start count

The contents of this register can be used to position the start of the LED1 ambient conversion signal with respect to the PRP, as specified in the PRPCOUNT register. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.



# Figure 94. ALED1CONVEND: LED1 Ambient Convert End Count Register (Address = 14h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ALED1CONVEND[15:0]				
11	10	9	8	7	6	5	4	3	2	1	0		
ALED1CONVEND[15:0]													

This register sets the end timing value for the ambient LED1 conversion.

Bits 23:16 Must be 0

Bits 15:0 ALED1CONVEND[15:0]: LED1 ambient convert end count

The contents of this register can be used to position the end of the LED1 ambient conversion signal with respect to the PRP. The count is specified as the number of 4-MHz clock cycles. Refer to the *Using the Timer Module* section for details.

Figure 95. ADCRSTSTCT0: ADC Reset 0 Start Count Register (Address = 15h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12	
0	0	0	0	0	0	0	0		ADCRSTSTCT0[15:0]			
11	10	9	8	7	6	5	4	3	2	1	0	
	ADCRSTSTCT0[15:0]											

This register sets the start position of the ADC0 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTSTCT0[15:0]: ADC RESET 0 start count

The contents of this register can be used to position the start of the ADC reset conversion signal (default value after reset is 0000h). Refer to the *Using the Timer Module* section for details.

Figure 96. ADCRSTENDCT0: ADC Reset 0 End Count Register (Address = 16h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ADCRSTENDCT0[15:0]				
11	10	9	8	7	6	5	4	3	2	1	0		
	ADCRSTENDCT0[15:0]												

This register sets the end position of the ADC0 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTENDCT0[15:0]: ADC RESET 0 end count

The contents of this register can be used to position the end of the ADC reset conversion signal (default value after reset is 0000h). Refer to the *Using the Timer Module* section for details.



Figure 97. ADCRSTSTCT1: ADC Reset 1 Start Count Register (Address = 17h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ADCRSTS	TCT1[15:0]			
11	10	9	8	7	6	5	4	3	2 1				
	ADCRSTSTCT1[15:0]												

This register sets the start position of the ADC1 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTSTCT1[15:0]: ADC RESET 1 start count

The contents of this register can be used to position the start of the ADC reset conversion. Refer to the *Using the Timer Module* section for details.

Figure 98. ADCRSTENDCT1: ADC Reset 1 End Count Register (Address = 18h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		ADCRSTEN		
11	10	9	8	7	6	5	4	3	2	1	0
ADCRSTENDCT1[15:0]											

This register sets the end position of the ADC1 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTENDCT1[15:0]: ADC RESET 1 end count

The contents of this register can be used to position the end of the ADC reset conversion. Refer to the *Using the Timer Module* section for details.

Figure 99. ADCRSTSTCT2: ADC Reset 2 Start Count Register (Address = 19h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12	
0	0	0	0	0	0	0	0		ADCRSTS	TCT2[15:0]		
11	10	9	8	7	6	5	4	3	2	1	0	
	ADCRSTSTCT2[15:0]											

This register sets the start position of the ADC2 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTSTCT2[15:0]: ADC RESET 2 start count

The contents of this register can be used to position the start of the ADC reset conversion. Refer to the *Using the Timer Module* section for details.



Figure 100. ADCRSTENDCT2: ADC Reset 2 End Count Register (Address = 1Ah, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12		
0	0	0	0	0	0	0	0		ADCRSTENDCT2[15:0]				
11	10	9	8	7	6	5	4	3	2	1	0		
	ADCRSTENDCT2[15:0]												

This register sets the end position of the ADC2 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTENDCT2[15:0]: ADC RESET 2 end count

The contents of this register can be used to position the end of the ADC reset conversion. Refer to the *Using the Timer Module* section for details.

Figure 101. ADCRSTSTCT3: ADC Reset 3 Start Count Register (Address = 1Bh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		ADCRSTS		
11	10	9	8	7	6	5	4	3	2	0	
ADCRSTSTCT3[15:0]											

This register sets the start position of the ADC3 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTSTCT3[15:0]: ADC RESET 3 start count

The contents of this register can be used to position the start of the ADC reset conversion. Refer to the *Using the Timer Module* section for details.

Figure 102. ADCRSTENDCT3: ADC Reset 3 End Count Register (Address = 1Ch, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12	
0	0	0	0	0	0	0	0		ADCRSTENDCT3[15:0]  2 1 0			
11	10	9	8	7	6	5	4	3	2	1	0	
	ADCRSTENDCT3[15:0]											

This register sets the end position of the ADC3 reset conversion signal.

Bits 23:16 Must be 0

Bits 15:0 ADCRSTENDCT3[15:0]: ADC RESET 3 end count

The contents of this register can be used to position the end of the ADC reset conversion signal (default value after reset is 0000h). Refer to the *Using the Timer Module* section for details.



Figure 103. PRPCOUNT: Pulse Repetition Period Count Register (Address = 1Dh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12	
0	0	0	0	0	0	0	0	PRPCOUNT[15:0]				
11	10	9	8	7	6	5	4	3	2	1	0	
PRPCOUNT[15:0]												

This register sets the device pulse repetition period count.

Bits 23:16 Must be 0

Bits 15:0 PRPCOUNT[15:0]: Pulse repetition period count

The contents of this register can be used to set the pulse repetition period (in number of clock cycles of the 4-MHz clock). The PRPCOUNT value must be set in the range of 800 to 64000. Values below 800 do not allow sufficient sample time for the four samples; see the *Electrical Characteristics* table.

Figure 104. CONTROL1: Control Register 1 (Address = 1Eh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12	
0	0	0	0	0	0	0	0	0	0	0	0	
11	10	9	8	7	6	5	4	3	2	1	0	
0	0	0	TIMEREN	NUMAV[7:0]								

This register configures the clock alarm pin and timer.

Bits 23:9 Must be 0

Bit 8 TIMEREN: Timer enable

0 = Timer module is disabled and all internal clocks are off (default after reset)

1 = Timer module is enabled

Bits 7:0 NUMAV[7:0]: Number of averages

Specify an 8-bit value corresponding to the number of ADC samples to be averaged -1.

For example, to average four ADC samples, set NUMAV[7:0] equal to 3.

The maximum number of averages is 16. Any setting of NUMAV[7:0] greater than or equal to a decimal value of 15 results in the number of averages getting set to 16.

Figure 105. SPARE1: SPARE1 Register For Future Use (Address = 1Fh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	0	0	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0

This register is a spare register and is reserved for future use.

Bits 23:0 Must be 0



# Figure 106. TIAGAIN: Transimpedance Amplifier Gain Setting Register (Address = 20h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	ENSEP GAIN	STAGE2 EN1	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	STG2GAIN1[2:0]				C	F_LED1[4:0	RF_LED1[2:0]				

This register sets the device transimpedance amplifier gain mode and feedback resistor and capacitor values.

Bits 23:16 Must be 0

Bit 15 ENSEPGAIN: Enable separate gain mode

 $0 = \text{The R}_F$ ,  $C_F$  values and stage 2 gain settings are the same for both the LED2 and LED1 signals; the values are specified by the bits (RF\_LED2, CF\_LED2, STAGE2EN2,

STG2GAIN2) in the TIA AMB GAIN register (default after reset)

1 = The  $R_F$ ,  $C_F$  values and stage 2 gain settings can be independently set for the LED2 and LED1 signals. The values for LED1 are specified using the bits (RF\_LED1, CF\_LED1, STAGE2EN1, STG2GAIN1) in the TIAGAIN register, whereas the values for LED2 are specified using the corresponding bits in the TIA\_AMB\_GAIN register.

Bit 14 STAGE2EN1: Enable stage 2 for LED 1

0 = Stage 2 is bypassed (default after reset)

1 = Stage 2 is enabled with the gain value specified by the STG2GAIN1[2:0] bits

Bits 13:11 Must be 0

Bits 10:8 STG2GAIN1[2:0]: Program stage 2 gain for LED1

000 = 0 dB, or linear gain of 1 (default after 100 = 12 dB, or linear gain of 4

reset) 101 = Do not use001 = 3.5 dB, or linear gain of 1.5 110 = Do not use

010 = 6 dB, or linear gain of 2 011 = 9.5 dB, or linear gain of 3

Bits 7:3 CF\_LED1[4:0]: Program C<sub>F</sub> for LED1

00000 = 5 pF (default after reset) 00100 = 25 pF + 5 pF 00001 = 5 pF + 5 pF 01000 = 50 pF + 5 pF 00010 = 15 pF + 5 pF 10000 = 150 pF + 5 pF

Note that any combination of these  $C_F$  settings is also supported by setting multiple bits to 1. For example, to obtain  $C_F = 100$  pF, set bits 7:3 = 01111.

111 = Do not use

Bits 2:0 RF\_LED1[2:0]: Program R<sub>F</sub> for LED1

 $000 = 500 \text{ k}\Omega \text{ (default after reset)}$   $100 = 25 \text{ k}\Omega$   $001 = 250 \text{ k}\Omega$   $101 = 10 \text{ k}\Omega$   $110 = 1 \text{ M}\Omega$   $110 = 1 \text{ M}\Omega$   $111 = 10 \text{ k}\Omega$   $111 = 10 \text{ k}\Omega$ 



Figure 107. TIA\_AMB\_GAIN: Transimpedance Amplifier and Ambient Cancellation Stage Gain Register (Address = 21h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0		AMBD	AC[3:0]		FLTR CNRSEL	STAGE2 EN2	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	S.	TG2GAIN[2:	0]	CF_LED2[4:0]					R	F_LED2[2:	0]

This register configures the ambient light cancellation amplifier gain, cancellation current, and filter corner frequency.

Bits 23:20 Must be 0

### Bits 19:16 AMBDAC[3:0]: Ambient DAC value

These bits set the value of the cancellation current.

$0000 = 0 \mu A \text{ (default after reset)}$	$1000 = 8 \mu A$
$0001 = 1 \mu A$	$1001 = 9 \mu A$
$0010 = 2 \mu A$	$1010 = 10 \mu A$
$0011 = 3 \mu A$	1011 = Do not use
$0100 = 4 \mu A$	1100 = Do not use
$0101 = 5 \mu A$	1101 = Do not use
$0110 = 6 \mu A$	1110 = Do not use
$0111 = 7 \mu A$	1111 = Do not use

#### Bit 15 Must be 0

### Bit 14 STAGE2EN2: Stage 2 enable for LED 2

0 = Stage 2 is bypassed (default after reset)

1 = Stage 2 is enabled with the gain value specified by the STG2GAIN2[2:0] bits

#### Bits 13:11 Must be 0

### Bits 10:8 STG2GAIN2[2:0]: Stage 2 gain setting for LED 2

000 = 0 dB, or linear gain of 1 (default after reset)

001 = 3.5 dB, or linear gain of 1.5 010 = 6 dB, or linear gain of 2

011 = 9.5 dB, or linear gain of 3

100 = 12 dB, or linear gain of 4

101 = Do not use 110 = Do not use 111 = Do not use

## Bits 7:3 CF\_LED[4:0]: Program C<sub>F</sub> for LEDs

00000 = 5 pF (default after reset)	00100 = 25 pF + 5 pF
00001 = 5 pF + 5 pF	01000 = 50 pF + 5 pF
00010 = 15 pF + 5 pF	10000 = 150 pF + 5 pF

Note that any combination of these  $C_F$  settings is also supported by setting multiple bits to 1. For example, to obtain  $C_F = 100$  pF, set D[7:3] = 01111.

# Bits 2:0 RF\_LED[2:0]: Program $R_F$ for LEDs

$000 = 500 \text{ k}\Omega$	$100 = 25 \text{ k}\Omega$
$001 = 250 \text{ k}\Omega$	$101 = 10 \text{ k}\Omega$
$010 = 100 \text{ k}\Omega$	$110 = 1 M\Omega$
$011 = 50 \text{ k}\Omega$	111 = None



Figure 108. LEDCNTRL: LED Control Register (Address = 22h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12			
0	0	0	0	0	0	LED_RA	LED_RANGE[1:0]		LED1[7:0]					
11	10	9	8	7	6	5	4	3	2	1	0			
	LED.	1[7:0]			LED2[7:0]									

This register sets the LED current range and the LED1 and LED2 drive current.

Bits 23:18 Must be 0

Bits 17:16 LED\_RANGE[1:0]: LED range

These bits program the full-scale LED current range for Tx. Table 7 details the settings.

Bits 15:8 LED1[7:0]: Program LED current for LED1 signal

Use these register bits to specify the LED current setting for LED1 (default after reset is 00h).

The nominal value of the LED current is given by Equation 7, where the full-scale LED current is either 0 mA or 50 mA (as specified by the LED\_RANGE[1:0] register bits).

Bits 7:0 LED2[7:0]: Program LED current for LED2 signal

Use these register bits to specify the LED current setting for LED2 (default after reset is 00h).

The nominal value of LED current is given by Equation 8, where the full-scale LED current is either 0 mA or 50 mA (as specified by the LED RANGE[1:0] register bits).

Table 7. Full-Scale LED Current across Tx Reference Voltage Settings<sup>(1)</sup>

LED_RANGE[1:	TX_REF = 0.25 V		TX_REF	= 0.5 V	TX_REF	= 0.75 V	TX_REF = 1.0 V		
0]	I <sub>MAX</sub>	V <sub>HR</sub> <sup>(2)</sup>	I <sub>MAX</sub>	V <sub>HR</sub>	I <sub>MAX</sub>	$V_{HR}$	I <sub>MAX</sub>	$V_{HR}$	
00 (default after reset)	50 mA	0.75 V	100 mA	1.1 V	Do not use	_	Do not use	_	
01	25 mA	0.7 V	50 mA	1.0 V	75 mA	1.3 V	100 mA	1.6 V	
10	50 mA	50 mA 0.75 V		1.1 V	Do not use	_	Do not use	-	
11	Tx is off — Tx		Tx is off	_	Tx is off	_	Tx is off	_	

(1) For a 3-V to 3.6-V supply, use TX\_REF = 0.25 or 0.5 V. For a 4.75-V to 5.25-V supply, use TX\_REF = 0.75 V or 1.0 V.

 $\frac{\mathsf{LED1[7:0]}}{256} \times \mathsf{Full}\text{-Scale Current} \tag{7}$   $\mathsf{LED2[7:0]}$ 

256 × Full-Scale Current

Product Folder Links: AFE4403

(8)

<sup>(2)</sup> V<sub>HR</sub> refers to the headroom voltage (over and above the LED forward voltage and cable voltage drop) needed on the LED\_DRV\_SUP. The V<sub>HR</sub> values specified are for the H-bridge configuration. In the common anode configuration, V<sub>HR</sub> can be lower by 0.25 V.



### Figure 109. CONTROL2: Control Register 2 (Address = 23h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	DYNAMI C1	0	TX_REF1	TX_REF0	0	0	DYNAMI C2	0	0
11	10	9	8	7	6	5	4	3	2	1	0
TXBRG MOD	DIGOUT_ TRI STATE	XTAL DIS	EN_ SLOW_ DIAG	0	0	0	DYNAMI C3	DYNAMI C4	PDNTX	PDNRX	PDNAFE

This register controls the LED transmitter, crystal, and the AFE, transmitter, and receiver power modes.

Bits 23:21 Must be 0
Bit 20 DYNAMIC1

0 = Transmitter is not powered down during dynamic power-down phase 1 = Transmitter is powered down during dynamic power-down phase

Bit 19 Must be 0

Bits 18:17 TX\_REF[1:0]: Tx reference voltage

These bits set the transmitter reference voltage. This Tx reference voltage is available on the device TX\_REF pin.

00 = 0.25-V Tx reference voltage (default value after reset)

01 = 0.5-V Tx reference voltage 10 = 1.0-V Tx reference voltage

11 = 0.75-V Tx reference voltage, D3

Bits 16:15 Must be 0
Bit 14 DYNAMIC2

0 = Part of the ADC is not powered down during dynamic power-down phase 1 = Part of the ADC is powered down during dynamic power-down phase

Bit 11 TXBRGMOD: Tx bridge mode

0 = LED driver is configured as an H-bridge (default after reset)

1 = LED driver is configured as a push-pull

Bit 10 DIGOUT\_TRISTATE: Tri-state bit for the ADC\_RDY and DIAG\_END pins

0 = ADC\_RDY and DIAG\_END are not tri-stated 1 = ADC\_RDY and DIAG\_END are tri-stated

Bit 9 XTALDIS: Crystal disable mode

0 = The crystal module is enabled; the 8-MHz crystal must be connected to the XIN and XOUT pins

1 = The crystal module is disabled; an external 8-MHz clock must be applied to the XIN pin

Bit 8 EN\_SLOW\_DIAG: Fast diagnostics mode enable

0 = Fast diagnostics mode, 8 ms (default value after reset)

1 = Slow diagnostics mode, 16 ms

Bits 7:5 Must be 0
Bit 4 DYNAMIC3

0 = TIA is not powered down during dynamic power-down phase1 = TIA is powered down during dynamic power-down phase

Bit 3 DYNAMIC4

0 = The rest of the ADC is not powered down during dynamic power-down phase 1 = The rest of the ADC is powered down during dynamic power-down phase



Bit 2 PDN TX: Tx power-down

0 = The Tx is powered up (default after reset)1 = Only the Tx module is powered down

Bit 1 PDN\_RX: Rx power-down

0 = The Rx is powered up (default after reset)1 = Only the Rx module is powered down

Bit 0 PDN\_AFE: AFE power-down

0 = The AFE is powered up (default after reset)

1 = The entire AFE is powered down (including the Tx, Rx, and diagnostics blocks)

Figure 110. SPARE2: SPARE2 Register For Future Use (Address = 24h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	0	0	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0

This register is a spare register and is reserved for future use.

#### Bits 23:0 Must be 0

Figure 111. SPARE3: SPARE3 Register For Future Use (Address = 25h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	0	0	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0

This register is a spare register and is reserved for future use.

#### Bits 23:0 Must be 0

Figure 112. SPARE4: SPARE4 Register For Future Use (Address = 26h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	0	0	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0

This register is a spare register and is reserved for future use.

#### Bits 23:0 Must be 0

Figure 113. RESERVED1: RESERVED1 Register For Factory Use Only (Address = 27h, Reset Value = XXXXh)

	23	22	21	20	19	18	17	16	15	14	13	12
	X <sup>(1)</sup>	Χ	Χ	Χ	Х	Х	Х	Х	Х	Х	Х	Х
			9									0
ſ	Χ	Χ	Х	Χ	Х	Х	Х	Х	Х	Х	Х	Х

(1) X = don't care.



This register is reserved for factory use. Readback values vary between devices.

Figure 114. RESERVED2: RESERVED2 Register For Factory Use Only (Address = 28h, Reset Value = XXXXh)

23	22	21	20	19	18	17	16	15	14	13	12
X <sup>(1)</sup>	Χ	Χ	Χ	Χ	Х	Χ	Χ	Χ	Χ	Χ	Χ
11	10	9	8	7	6	5	4	3	2	1	0
Χ	Х	Х	Х	Χ	Х	Х	Х	Х	Х	Х	Χ

<sup>(1)</sup> X = don't care.

This register is reserved for factory use. Readback values vary between devices.

Figure 115. ALARM: Alarm Register (Address = 29h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	0	0	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0

This register controls the alarm pin functionality.

Bits 23:0 Must be 0

Figure 116. LED2VAL: LED2 Digital Sample Value Register (Address = 2Ah, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
					LED2V	AL[23:0]					
11	10	9	8	7	6	5	4	3	2	1	0
					LED2V	AL[23:0]					

### Bits 23:0 LED2VAL[23:0]: LED2 digital value

This register contains the digital value of the latest LED2 sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

Figure 117. ALED2VAL: Ambient LED2 Digital Sample Value Register (Address = 2Bh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
					ALED2V	'AL[23:0]					
11	10	9	8	7	6	5	4	3	2	1	0
	ALED2VAL[23:0]										

# Bits 23:0 ALED2VAL[23:0]: LED2 ambient digital value

This register contains the digital value of the latest LED2 ambient sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.



Figure 118. LED1VAL: LED1 Digital Sample Value Register (Address = 2Ch, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
					LED1V	AL[23:0]					
11	10	9	8	7	6	5	4	3	2	1	0
					LED1V	AL[23:0]					

#### Bits 23:0 LED1VAL[23:0]: LED1 digital value

This register contains the digital value of the latest LED1 sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

Figure 119. ALED1VAL: Ambient LED1 Digital Sample Value Register (Address = 2Dh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
					ALED1V	'AL[23:0]					
11	10	9	8	7	6	5	4	3	2	1	0
					ALED1V	'AL[23:0]					

#### Bits 23:0 ALED1VAL[23:0]: LED1 ambient digital value

This register contains the digital value of the latest LED1 ambient sample converted by the ADC. The ADC\_RDY signal goes high each time that the contents of this register are updated. The host processor must readout this register before the next sample is converted by the AFE.

Figure 120. LED2-ALED2VAL: LED2-Ambient LED2 Digital Sample Value Register (Address = 2Eh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
					LED2-ALE	D2VAL[23:0]					
11	10	9	8	7	6	5	4	3	2	1	0
					LED2-ALE	D2VAL[23:0]					

### Bits 23:0 LED2-ALED2VAL[23:0]: (LED2 – LED2 ambient) digital value

This register contains the digital value of the LED2 sample after the LED2 ambient is subtracted. The host processor must readout this register before the next sample is converted by the AFE.

Note that this value is inverted when compared to waveforms shown in many publications.

Figure 121. LED1-ALED1VAL: LED1-Ambient LED1 Digital Sample Value Register (Address = 2Fh, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
					LED1-ALED	01VAL[23:0]					
11	10	9	8	7	6	5	4	3	2	1	0
					LED1-ALED	01VAL[23:0]					

### Bits 23:0 LED1-ALED1VAL[23:0]: (LED1 – LED1 ambient) digital value

This register contains the digital value of the LED1 sample after the LED1 ambient is subtracted from it. The host processor must readout this register before the next sample is converted by the AFE.

Note that this value is inverted when compared to waveforms shown in many publications.



Figure 122. DIAG: Diagnostics Flag Register (Address = 30h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	0	0	0	PD_ALM
11	10	9	8	7	6	5	4	3	2	1	0
LED_ ALM	LED2 OPEN	LED1 OPEN	LEDSC	OUTNSH GND	OUTPSH GND	PDOC	PDSC	INNSC GND	INPSC GND	INNSC LED	INPSC LED

This register is read only. This register contains the status of all diagnostic flags at the end of the diagnostics sequence. The end of the diagnostics sequence is indicated by the signal going high on DIAG\_END pin.

Bits 23:13 Read only

Bit 12 PD\_ALM: Power-down alarm status diagnostic flag

This bit indicates the status of PD\_ALM.

0 = No fault (default after reset)

1 = Fault present

Bit 11 LED ALM: LED alarm status diagnostic flag

This bit indicates the status of LED\_ALM.

0 = No fault (default after reset)

1 = Fault present

Bit 10 LED2OPEN: LED2 open diagnostic flag

This bit indicates that LED2 is open. 0 = No fault (default after reset)

1 = Fault present

Bit 9 LED1OPEN: LED1 open diagnostic flag

This bit indicates that LED1 is open. 0 = No fault (default after reset)

1 = Fault present

This bit indicates that LED2 is open. 0 = No fault (default after reset)

1 = Fault present

Bit 8 LEDSC: LED short diagnostic flag

This bit indicates an LED short. 0 = No fault (default after reset)

1 = Fault present

Bit 7 OUTNSHGND: OUTN to GND diagnostic flag

This bit indicates that OUTN is shorted to the GND cable.

0 = No fault (default after reset)

1 = Fault present

Bit 6 OUTPSHGND: OUTP to GND diagnostic flag

This bit indicates that OUTP is shorted to the GND cable.

0 = No fault (default after reset)

1 = Fault present

Bit 5 PDOC: PD open diagnostic flag

This bit indicates that PD is open. 0 = No fault (default after reset)

1 = Fault present



Bit 4 PDSC: PD short diagnostic flag

This bit indicates a PD short. 0 = No fault (default after reset)

1 = Fault present

Bit 3 INNSCGND: INN to GND diagnostic flag

This bit indicates a short from the INN pin to the GND cable.

0 = No fault (default after reset)

1 = Fault present

Bit 2 INPSCGND: INP to GND diagnostic flag

This bit indicates a short from the INP pin to the GND cable.

0 = No fault (default after reset)

1 = Fault present

Bit 1 INNSCLED: INN to LED diagnostic flag

This bit indicates a short from the INN pin to the LED cable.

0 = No fault (default after reset)

1 = Fault present

Bit 0 INPSCLED: INP to LED diagnostic flag

This bit indicates a short from the INP pin to the LED cable.

0 = No fault (default after reset)

1 = Fault present

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Figure 123. CONTROL3: Control Register (Address = 31h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0	TX3_MO DE	0	0	0
11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	SOMI_ TRI	CLKOUT _TRI		CLKDIV[2:0	]

This register controls the clock divider ratio.

Bits 23:16 Must be 0

Bit 15 TX3 MODE: Selection of third LED

This bit transitions the control from the default two LEDs (on TXP, TXN) to the third LED on TX3.

0 = LEDs on TXP, TXN are active

1 = LED on TX3 is active. Timing engine controls on TXP are transferred to TX3. Maximum current setting supported for the third LED is 50 mA.

Bits 14:5 Must be 0

Bit 4 SOMI\_TRI: Serial data output 3-state mode

This bit determines the state of the SPISOMI output pin. In order to avoid loading the SPI bus when multiple devices are connected, this bit must be set to 1 (3-state mode) whenever the device SPI is inactive.

0 = SPISOMI output buffer is active (normal operation, default)

1 = SPISOMI output buffer is in 3-state mode

Bit 3 CLKOUT\_TRI: CLKOUT output 3-state mode

This bit determines the state of the CLKOUT output pin.

0 = CLKOUT buffer is active (normal operation, default)

1 = CLKOUT buffer is in 3-state mode

Bits 2:0 CLKDIV[2:0]: Clock divider ratio

These bits set the ratio of the clock divider and determine the frequency of CLKOUT relative to the input clock frequency.

Table 8 shows the clock divider ratio settings.

**Table 8. Clock Divider Ratio Settings** 

CLKDIV[2:0]	DIVIDER RATIO	INPUT CLOCK FREQUENCY RANGE
000	Divide-by-2	8 MHz to 12 MHz <sup>(1)</sup>
001	Do not use	Do not use
010	Divide-by-4	16 MHz to 24 MHz <sup>(1)</sup>
011	Divide-by-6	24 MHz to 36 MHz
100	Divide-by-8	32 MHz to 48 MHz
101	Divide-by-12	48 MHz to 60 MHz
110	Do not use	Do not use
111	Divide by 1 <sup>(2)</sup>	4 MHz to 6 MHz

<sup>(1)</sup> These frequency ranges can be used when generating the clock using the crystal.

<sup>(2)</sup> When using divide-by-1, the external clock should have a duty cycle between 48% to 52%.



Figure 124. PDNCYCLESTC: PDNCYCLESTC Register (Address = 32h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		PDNCYCLE	ESTC[15:0]	
11	10	9	8	7	6	5	4	3	2	1	0
	PDNCYCLESTC[15:0]										

Bits 23:16 Must be 0

### Bits 15:0 PDNCYCLESTC[15:0]: Dynamic (cycle-to-cycle) power-down start count

The contents of this register can be used to position the start of the PDN\_CYCLE signal with respect to the pulse repetition period (PRP). The count is specified as the number of cycles of CLKOUT. If the dynamic power-down feature is not required, then do not program this register.

Figure 125. PDNCYCLEENDC: PDNCYCLEENDC Register (Address = 33h, Reset Value = 0000h)

23	22	21	20	19	18	17	16	15	14	13	12
0	0	0	0	0	0	0	0		PDNCYCLE	ENDC[15:0]	
11	10	9	8	7	6	5	4	3	2	1	0
					PDNCYCLE	ENDC[15:0	]				

Bits 23:16 Must be 0

## Bits 15:0 PDNCYCLEENDC[15:0]: Dynamic (cycle-to-cycle) power-down end count

The contents of this register can be used to position the end of the PDN\_CYCLE signal with respect to the pulse repetition period (PRP). The count is specified as the number of cycles of CLKOUT. If the dynamic power-down feature is not required, then do not program this register.



# 9 Application and Implementation

#### 9.1 Application Information

The AFE4403 is ideally suited as an analog front-end for processing PPG (photoplethysmography) signals. The information contained in PPG signals can be used for measuring SPO2 as well as for monitoring heart rate. The high dynamic range of the device enables measuring SPO2 with a high degree of accuracy, even under conditions of low perfusion (ac:dc ratio). An SPO2 measurement system involves two different wavelength LEDs: usually Red and IR. By computing the ratio of the ac:dc at the two different wavelengths, SPO2 can be calculated. Heart rate monitoring systems can also benefit from the high dynamic range of the AFE4403, which enables a high-fidelity pulsating signal to be captured, even in cases where the signal strength is low.

### 9.2 Typical Application

Device connections in a typical application is shown in Figure 126. The schematic shows a cabled application in which the LEDs and photodiode are connected to the device through a cable. However, in an application without cables, the LEDs and photodiode can be directly connected to the TXP, TXN, TX3, INP, and INN pins directly.

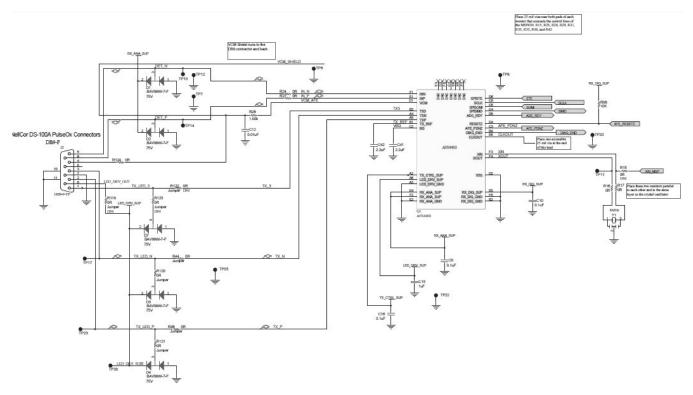


Figure 126. Schematic

#### 9.2.1 Design Requirements

An SPO2 application usually involves a Red LED and IR LED. In addition, a heart rate monitoring application can use a different wavelength LED, such as a Green LED. The LEDs can be connected either in the common anode configuration or H-bridge configuration to the TXP, TXN pins. The LED connected to the TX3 pin can only be connected in the common anode configuration.



### **Typical Application (continued)**

#### 9.2.2 Detailed Design Procedure

Refer to LED Configurations for different ways to connect the LEDs to the TXP, TXN, and TX3 pins. The photodiode (shown in Figure 127) receives light from both the Red and IR phases and usually has good sensitivities at both these wavelengths.



Figure 127. Photodiode

The photodiode connected as shown in Figure 127 operates in zero bias because of the negative feedback from the transimpedance amplifier. The signal current generated by the photodiode is converted into a voltage by the transimpedance amplifier, which has a programmable transimpedance gain. The rest of the signal chain then presents a voltage to the ADC. The full-scale output of the transimpedance amplifier is ±1 V and the full-scale input to the ADC is ±1.2 V. An automatic gain control (AGC) loop can be used to set the target dc voltage at the ADC input to approximately 50% of its full-scale. Such an AGC loop can control a combination of the LED current and TIA gain to achieve this target value.

#### 9.2.3 Application Curves

This section outlines the trends seen in the *Typical Characteristics* curves from an application perspective.

Figure 5 illustrates the receiver currents in external clock mode with CLKOUT tri-stated. The curve in Figure 5 are taken without the dynamic power-down feature enabled, so much lower currents can be achieved using the dynamic power-down feature. Enabling the crystal mode or removing the CLKOUT tri-state increases the receiver currents from the values depicted in the curve.

Figure 6 illustrates the transmitter currents with a zero LED current setting. The average LED current can be computed based on the value of the PRF and LED pulse durations, and can be added to the LED\_DRV\_SUP current described in Figure 6.

Figure 7 illustrates the total receiver current (analog plus digital supply) for different clock divider ratios. For each clock divider ratio, the external clock frequency is swept in frequency such that the divided clock changes between 3 MHz to 7 MHz. Note however that the supported range for the divided clock is 4 MHz to 6 MHz at each division ratio. Also, the external clock should be limited to be between 4 MHz to 60 MHz.

Figure 8 illustrates the power savings arising out of the dynamic power-down mode. This mode can be set by defining the start and end points for the signal PDN\_CYCLE within the pulse repetition period. In Figure 8, the LED pulse durations are chosen to be 100  $\mu$ s and the conversions are also chosen to be 100  $\mu$ s wide. Thus, the entire active period fits in 500  $\mu$ s. With the timing margins for  $t_1$  and  $t_2$  indicated in Figure 67, the PDN\_CYCLE pulse spans the rest of the pulse repetition period. As PRF reduces, the duty cycle of the PDN\_CYCLE pulse (as a fraction of the pulse repetition period) increases, which is the reason for the power reduction at lower PRFs as seen in Figure 8.

Figure 9 illustrates the power savings as a function of the PDN\_CYCLE duration at a fixed PRF of 100 Hz. A 100-Hz PRF corresponds to a period of 10 ms. Figure 9 indicates the PDN\_CYCLE duration swept from 0 ms to 9 ms. With higher durations of PDN\_CYCLE, the receiver power reduces.

Figure 10 illustrates the baseband response of the switched RC filter for a 5% and 25% duty cycle. When the duty cycle reduces, the effective bandwidth of the filter reduces.



### **Typical Application (continued)**

Figure 128 shows the SNR of the signal chain as a function of the output voltage level. The data are taken by looping back the transmitter outputs to the receiver inputs using an external op amp that converts the transmitter voltage to a receiver input current. The loopback op amp and external resistors are an extra source of noise in this measurement, so the actual noise levels are higher than the total noise of the transmitter plus the receiver. The SNR in this curve (and other curves) is expressed in terms of dBFS, where the full-scale of the channel is used as the reference level. Because the valid operating range of the signal chain is ±1 V, a full-scale of 2 V is used for converting the output noise to a dBFS number. %FS refers to the percentage of the output level as a function of the positive full-scale. For example, a 50 %FS curve corresponds to the case where the output level is 0.5 V. Also, the total noise in this curve is the total integrated noise in the digital output. All noise is contained in the Nyquist band, which extends from -PRF / 2 to PRF / 2.

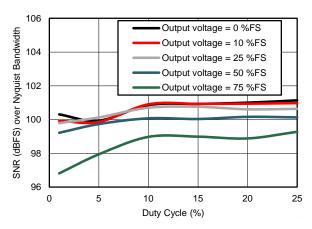


Figure 128. SNR over Nyquist Bandwidth vs Duty Cycle (Input Current with Tx-Rx Loopback)

Figure 129 is a representation of the same data as Figure 10. However, the noise is represented in terms of the input-referred noise current in pArms. By multiplying this number with the TIA gain setting (500 k in this case), the output noise voltage can be computed.

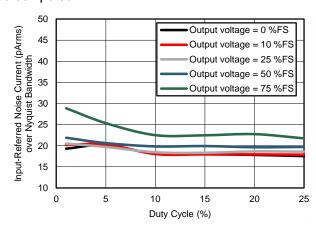


Figure 129. Input-Referred Noise Current over Nyquist Bandwidth vs Duty Cycle (Input Current with Tx-Rx Loopback)

Figure 13 illustrates the SNR from the receiver as a function of the sampling duty cycle (which is the sampling pulse duration referred to the pulse repetition period) for different settings of TIA gain. This curve is taken at 100-Hz PRF. The maximum duty cycle is limited to 25%. A lower sampling duty cycle also means a lower LED pulse duration duty cycle, which results in power saving.



### **Typical Application (continued)**

Figure 14 illustrates the input-referred noise corresponding to Figure 13. Figure 15 and Figure 16 illustrate the SNR and input-referred noise current in a 0.1-Hz to 20-Hz band for the LED-ambient data. By performing a digital ambient subtraction, the low-frequency noise in the signal chain can be significantly attenuated. The noise levels in the bandwidth of interest are lower than the noise over the full Nyquist bandwidth. For a PPG signal, the signal band of interest is usually less than 10 Hz. By performing some digital low-pass filtering in the processor, this noise reduction can be achieved. Figure 17 and Figure 18 illustrate the noise reduction from ADC averaging. TI therefore recommends setting the number of ADC averages to the maximum allowed at a given PRF. Figure 19 and Figure 20 illustrate the noise at different PRFs over a 20-Hz bandwidth. At a higher PRF, the 20-Hz noise band is a smaller fraction of the Nyquist band. Thus, noise is lower at higher PRFs in these figures. Figure 21 and Figure 22 illustrate the noise at different PRFs over a 20-Hz bandwidth with dynamic power-down mode enabled. The active window remains as 500 µs and all samples and conversions are performed at this time. For the rest of the period, the device is in dynamic power-down with the t1 and t2 values as described in Figure 67. Again, the noise reduces with higher PRF. Figure 23 and Figure 24 illustrate the noise as a function of the PDN\_CYCLE duration varied from 0 ms to 9 ms, with the active duration (available for conversion) occupying the rest of the period. With higher PDN\_CYCLE durations, the number of allowed ADC averages reduces, ehich explains the slight increase in noise at higher PDN CYCLE durations. Figure 25 and Figure 26 illustrate the noise as a function of temperature over a 20-Hz bandwidth. The measurements are performed with a transmitreceive loopback as explained earlier. The input current is maintained at 1 µA. Thus, for 250-k gain setting, the output voltage is 0.5 V and for a 500-k gain setting, the output voltage is 1 V. Figure 27 and Figure 28 illustrate the noise reduction using additional gain in stage 2. Figure 29 shows the noise as a function of the internal (divided) clock frequency. The external clock is varied from 7 MHz to 14 MHz with a clock division ratio of 2. This range of external clock results in the internal clock varying from 3.5 MHz to 7 MHz. Out of this range, 4 MHz to 6 MHz is the allowed range for the internal (divided) clock at all clock division ratios. Figure 30 illustrates the deviation in the measured LED current with respect to the calculated current when the LED current code is swept from 0 to 255 in steps of 1.

Figure 31 and Figure 32 illustrate the transmitter+receiver noise (in external loopback mode) as a function of the TX\_REF voltage setting. At lower TX\_REF voltages, there is a slight increase in the transmitter noise. This increase is not very apparent from the curves because the transmitter noise is at a level much lower than the total noise. Figure 33 illustrates the transmitter current as a function of the current setting code. Figure 34 illustrates the spread of the transmitter current taken across a large number of devices for the same current setting. Figure 35 illustrates how the LED current changes linearly with the TX\_REF voltage for a fixed code.



## 10 Power Supply Recommendations

The AFE4403 has two sets of supplies: the receiver supplies (RX\_ANA\_SUP, RX\_DIG\_SUP) and the transmitter supplies (TX\_CTRL\_SUP, LED\_DRV\_SUP). The receiver supplies can be between 2.0 V to 3.6 V, whereas the transmitter supplies can be between 3.0 V to 5.25 V. Another consideration that determines the minimum allowed value of the transmitter supplies is the forward voltage of the LEDs being driven. The current source and switches inside the AFE require voltage headroom that mandates the transmitter supply to be a few hundred millivolts higher than the LED forward voltage. TX\_REF is the voltage that governs the generation of the LED current from the internal reference voltage. Choosing the lowest allowed TX\_REF setting reduces the additional headroom required but results in higher transmitter noise. Other than for the highest-end clinical SPO2 applications, this extra noise resulting from a lower TX\_REF setting can be acceptable.

Consider a design where the LEDs are meant to be used in common anode configuration with a current setting of 50 mA. Assume that the LED manufacturer mentions the highest forward voltage of the LEDs is 2.5 V at this current setting. Further, assume that the TX\_REF voltage is set to 0.5 V. The voltage headroom required in this case is 1 V. Thus, the LED\_DRV\_SUP must be driven with a voltage level greater than or equal to 3.5 V (2.5 V plus 1 V).

LED\_DRV\_SUP and TX\_CTRL\_SUP are recommended to be tied together to the same supply (between 3.0 V to 5.25 V). The external supply (connected to the common anode of the two LEDs) must be high enough to account for the forward drop of the LEDs as well as the voltage headroom required by the current source and switches inside the AFE. In most cases, this voltage is expected to fall below 5.25 V; thus the external supply can be the same as LED\_DRV\_SUP. However, there may be cases (for instance when two LEDs are connected in series) where the voltage required on the external supply is higher than 5.25 V. Such a case must be handled with care to ensure that the voltage on the TXP and TXN pins remains less than 5.25 V and never exceeds the supply voltage of LED\_DRV\_SUP, TX\_CTRL\_SUP by more than 0.3 V.

Many scenarios of power management are possible.

**Case 1:** The LED forward voltage is such that a voltage of 3.3 V is acceptable on LED\_DRV\_SUP. In this case, a single 3.3-V supply can be used to drive all four pins (RX\_ANA\_SUP, RX\_DIG\_SUP, TX\_CTRL\_SUP, LED\_DRV\_SUP). Care should be taken to provide some isolation between the transmit and receive supplies because LED\_DRV\_SUP carries the high-switching current from the LEDs.

Case 2: A low-voltage supply of 2.2 V is available in the system. In this case, a boost converter can be used to derive the voltage for LED\_DRV\_SUP, as shown in Figure 130.

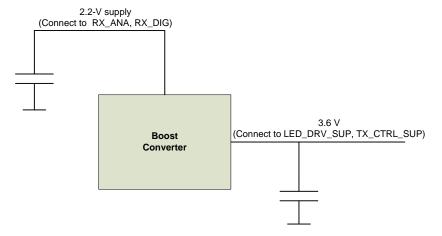


Figure 130. Boost Converter

The boost converter requires a clock (usually in the megahertz range) and there is usually a ripple at the boost converter output at this switching frequency. While this frequency is much higher than the signal frequency of interest (which is at maximum a few tens of hertz around dc), a small fraction of this switching noise can possibly alias to the low-frequency band. Therefore, TI strongly recommends that the switching frequency of the boost converter be offset from every multiple of the PRF by at least 20 Hz. This offset can be ensured by choosing the appropriate PRF.

Case 3: In cases where a high-voltage supply is available in the system, a buck converter or an LDO can be used to derive the voltage levels required to drive RX\_ANA and RX\_DIG, as shown in Figure 131.

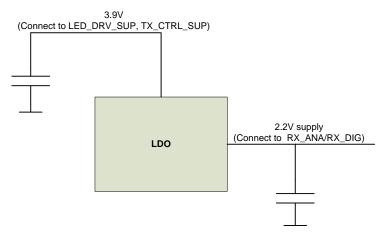


Figure 131. Buck Converter or an LDO

### 10.1 Power Consumption Considerations

The lowest power consumption mode of the AFE4403 corresponds to the following settings:

- PRF = 62.5 Hz,
- External clock mode (XTALDIS = 1), and
- CLKOUT tri-stated (CLKOUT\_TRI = 1).

With the above settings, the currents taken from the supplies are as shown in Table 9. The LED driver current is with zero LED current setting.

SUPPLY	VOLTAGE (V)	CURRENT (μA)
RX_ANA	2	490
RX_DIG	2	155
TX_CTRL_SUP	3	15
LED_DRV_SUP	3	55

**Table 9. Current Consumption in Normal Mode** 

Enabling the crystal (XTALDIS = 0) leads to an additional power consumption that can be estimated to be approximately equal to  $(2 \times C_{sh} + 0.5 \times C1 + 0.5 \times C2) \times 0.4 \times f_{XTAL}$ , where  $C_{sh}$  is the effective shunt capacitance of the crystal, C1 and C2 are the capacitances from the XIN and XOUT pins to ground, and  $f_{XTAL}$  is the frequency of the crystal.

Removing the CLKOUT tri-state leads to an additional power consumption of approximately  $C_{LOAD} \times V_{SUP} \times f$ , where  $V_{SUP}$  is the supply voltage of RX\_DIG in volts, f = 4 MHz,  $C_{LOAD} =$  the capacitive load on the CLKOUT pin + 2 pF.



The power consumption can be reduced significantly by using the dynamic power-down mode. An illustration of this mode is shown in Table 10, where:

- PRF = 62.5 Hz,
- Dynamic power-down is active for 14.7 ms every pulse repetition period,
- All four bits (DYNAMIC[4:1]) are set to 1,
- External clock mode (XTALDIS = 1), and
- CLKOUT is tri-stated (CLKOUT\_TRI = 1).

Table 10. Current Consumption in Dynamic Power-Down Mode

SUPPLY	VOLTAGE (V)	CURRENT (μA)
RX_ANA	2	150
RX_DIG	2	155
TX_CTRL_SUP	3	5
LED_DRV_SUP	3	5



# 11 Layout

### 11.1 Layout Guidelines

Some key layout guidelines are mentioned below:

- 1. TXP, TXN, and TX3 are fast-switching lines and should be routed away from sensitive reference lines as well as from the INP, INN inputs.
- 2. If the INP, INN lines are required to be routed over a long trace, TI recommends that VCM be used as a shield for the INP, INN lines.
- 3. The device can draw high-switching currents from the LED\_DRV\_SUP pin. Therefore, TI recommends having a decoupling capacitor electrically close to the pin.

### 11.2 Layout Example

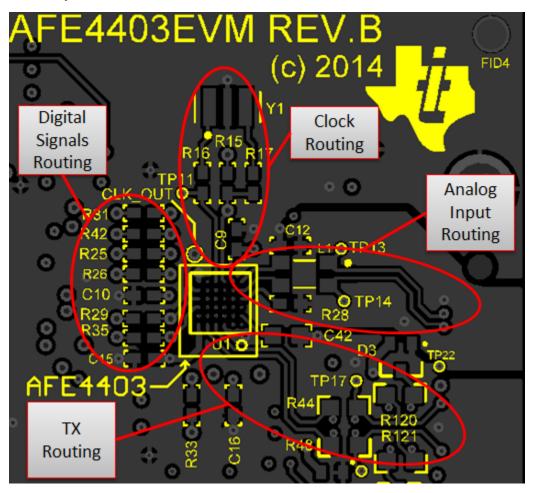


Figure 132. Example Layout

Submit Documentation Feedback



# 12 Device and Documentation Support

#### 12.1 Trademarks

SPI is a trademark of Motorola.

All other trademarks are the property of their respective owners.

## 12.2 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 12.3 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



## PACKAGE OPTION ADDENDUM

10-Dec-2020

#### PACKAGING INFORMATION

www.ti.com

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
AFE4403YZPR	ACTIVE	DSBGA	YZP	36	3000	RoHS & Green	SNAGCU	Level-1-260C-UNLIM	-20 to 70	AFE4403	Samples
AFE4403YZPT	ACTIVE	DSBGA	YZP	36	250	RoHS & Green	SNAGCU	Level-1-260C-UNLIM	-20 to 70	AFE4403	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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10-Dec-2020

PACKAGE MATERIALS INFORMATION

www.ti.com 10-Oct-2015

# TAPE AND REEL INFORMATION





	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
AFE4403YZPR	DSBGA	YZP	36	3000	180.0	8.4	3.16	3.16	0.71	4.0	8.0	Q1
AFE4403YZPT	DSBGA	YZP	36	250	180.0	8.4	3.16	3.16	0.71	4.0	8.0	Q1

www.ti.com 10-Oct-2015

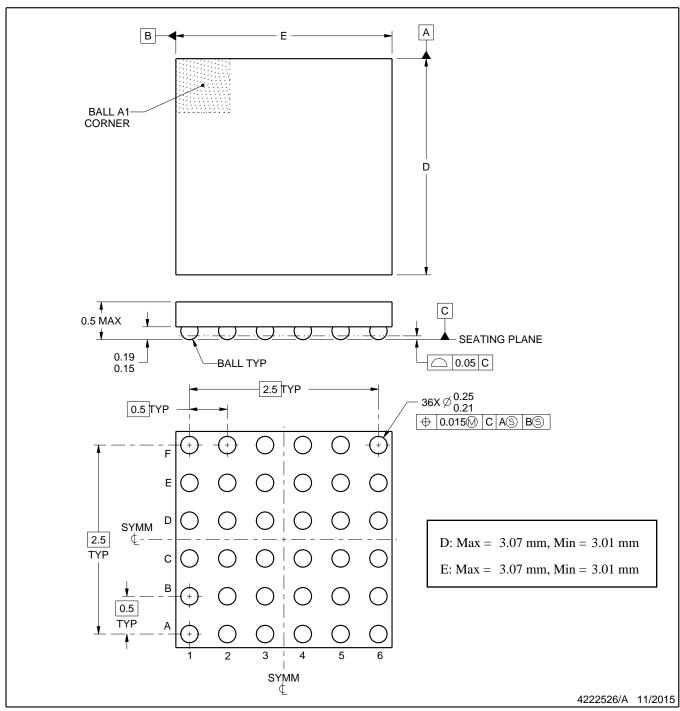


#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
AFE4403YZPR	DSBGA	YZP	36	3000	182.0	182.0	20.0
AFE4403YZPT	DSBGA	YZP	36	250	182.0	182.0	20.0



DIE SIZE BALL GRID ARRAY



## NOTES:

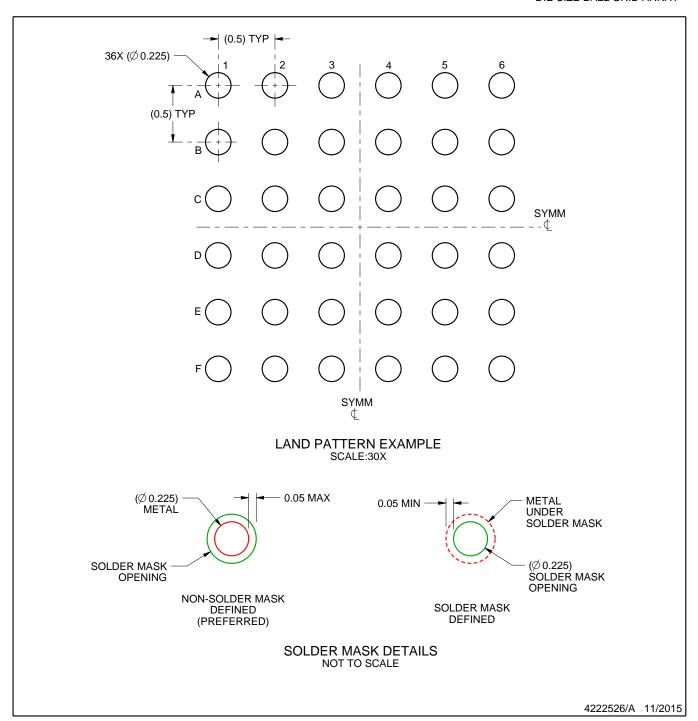
NanoFree Is a trademark of Texas Instruments.

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.

  2. This drawing is subject to change without notice.
- 3. NanoFree<sup>™</sup> package configuration.



DIE SIZE BALL GRID ARRAY

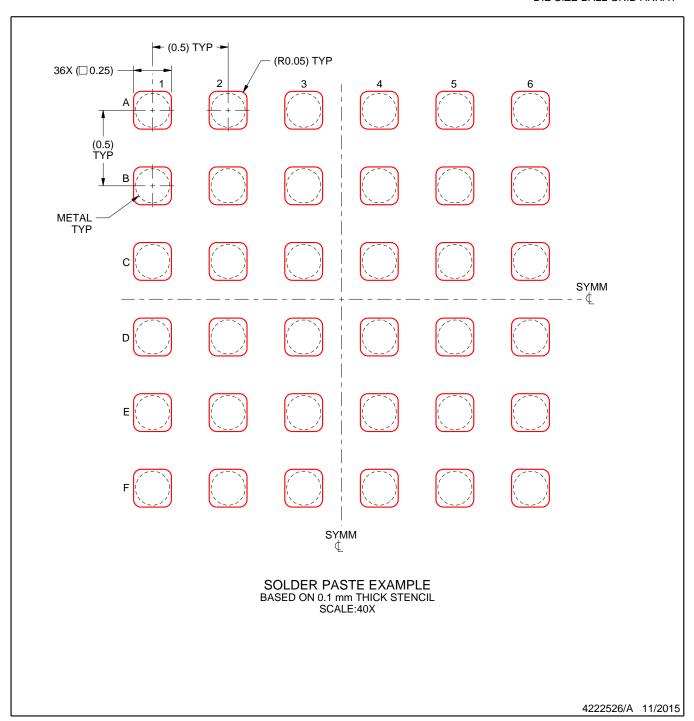


NOTES: (continued)

4. Final dimensions may vary due to manufacturing tolerance considerations and also routing constraints. For more information, see Texas Instruments literature number SNVA009 (www.ti.com/lit/snva009).



DIE SIZE BALL GRID ARRAY



NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release.



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